

28V Operation High Speed Voltage Regulators with Stand-by Function

GENERAL DESCRIPTION

The XC6701 series are positive voltage regulator ICs manufactured using CMOS process with 28V of operation voltage. The series consists of a voltage reference, an error amplifier, a current limiter, a thermal shutdown circuit and a phase compensation circuit plus a driver transistor.

The output voltage is selectable in 0.1V increments within the range of 1.8V to 18V which fixed by laser trimming technologies. The output stabilization capacitor (CL) is also compatible with low ESR ceramic capacitors.

The over current protection circuit and the thermal shutdown circuit are built-in. These two protection circuits will operate when the output current reaches current limit level or the junction temperature reaches temperature limit level.

The CE function enables the output to be turned off and the IC becomes a stand-by mode resulting in greatly reduced power consumption. Packages are selectable depending on the applications from SOT-25, SOT-89, SOT-89-5, USP-6C, SOT-223, and TO-252.

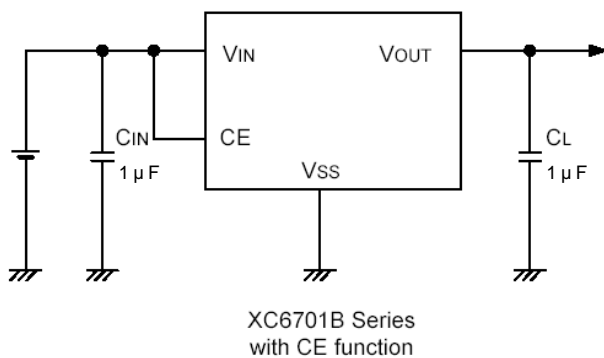
APPLICATIONS

- Car audio, Car navigation systems
- Note book computers, PDAs
- Home appliances
- Audio visuals, Digital cameras, Video cameras
- Cordless phones, Wireless communication

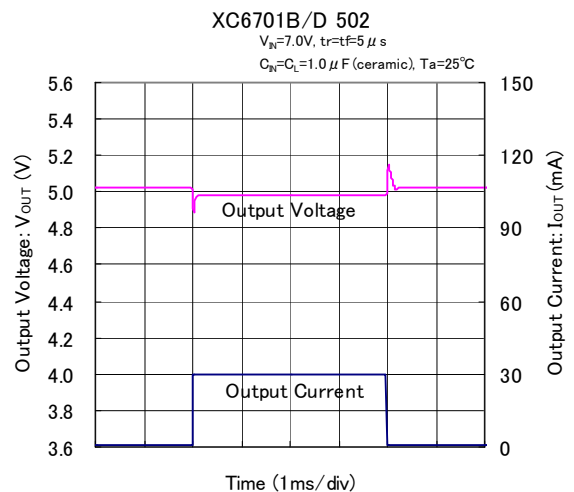
FEATURES

- Max Output Current** : More than 150mA (200mA limit)
($V_{IN}=V_{OUT(T)}+3.0V$)
- Dropout Voltage** : 300mV@ $I_{OUT}=20mA$
- Input Voltage Range** : 2.0V~28.0V
- Output Voltage Range** : 1.8V~18.0V (100mV increments)
- High Accuracy** : $\pm 2\%$
- Low Power Consumption** : 50 μA ($V_{OUT(T)}=5.0V$)
- Stand-by Current** : Less than 0.1 μA
- High Ripple Rejection** : 50dB@1kHz
- Operating Temperature** : -40 ~+85
- Low ESR Capacitor** : Ceramic Capacitor Compatible
(Internal Phase Compensation)
- Small Packages** : SOT-25, SOT-89, SOT-89-5,
USP-6C, SOT-223, TO-252

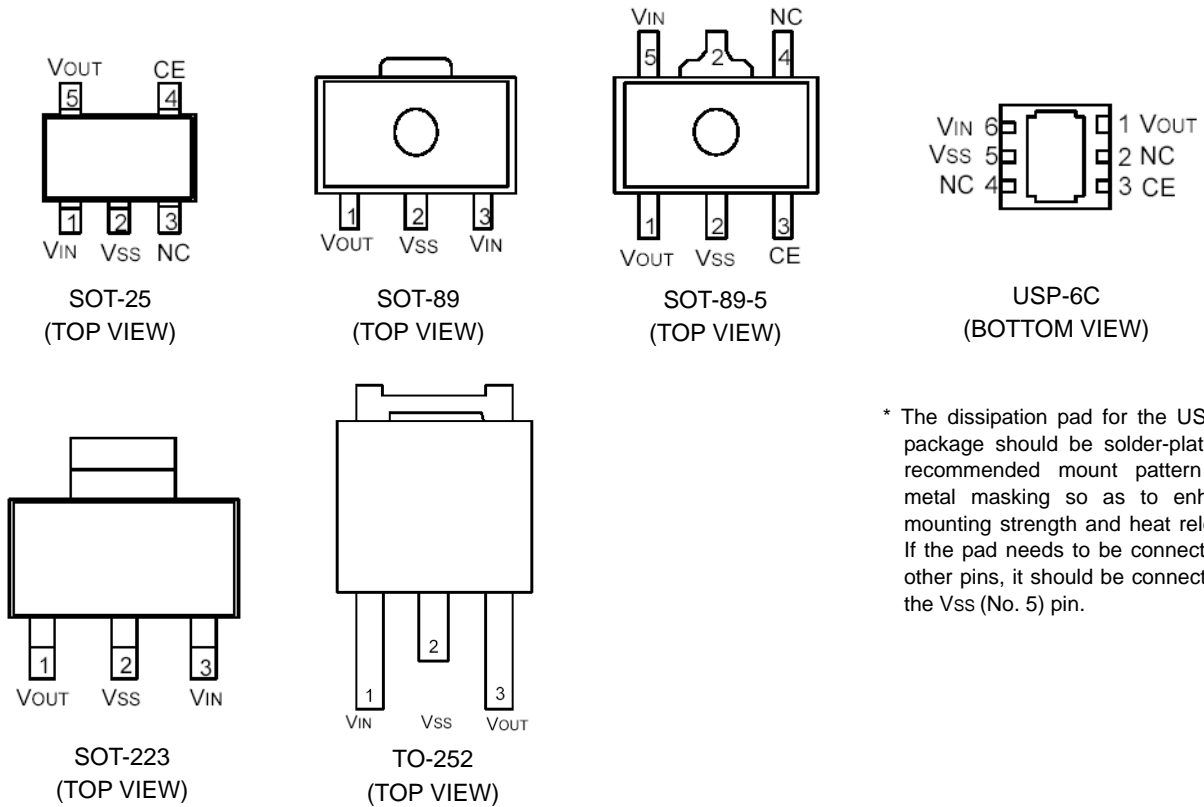
TYPICAL APPLICATION CIRCUITS



TYPICAL PERFORMANCE CHARACTERISTICS



PIN CONFIGURATION



* The dissipation pad for the USP-6C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the Vss (No. 5) pin.

PIN ASSIGNMENT

XC6701B Series

| PIN NUMBER | | | PIN NAME | FUNCTIONS |
|------------|----------|--------|----------|----------------|
| SOT-25 | SOT-89-5 | USP-6C | | |
| 1 | 5 | 6 | VIN | Power Input |
| 2 | 2 | 5 | Vss | Ground |
| 3 | 4 | 2, 4 | NC | No connection |
| 4 | 3 | 3 | CE | ON/OFF Control |
| 5 | 1 | 1 | VOUT | Output |

XC6701D Series

| PIN NUMBER | | | PIN NAME | FUNCTIONS |
|------------|---------|--------|----------|-------------|
| SOT-89 | SOT-223 | TO-252 | | |
| 3 | 3 | 1 | VIN | Power Input |
| 2 | 2 | 2 | Vss | Ground |
| 1 | 1 | 3 | VOUT | Output |

PRODUCT CLASSIFICATION

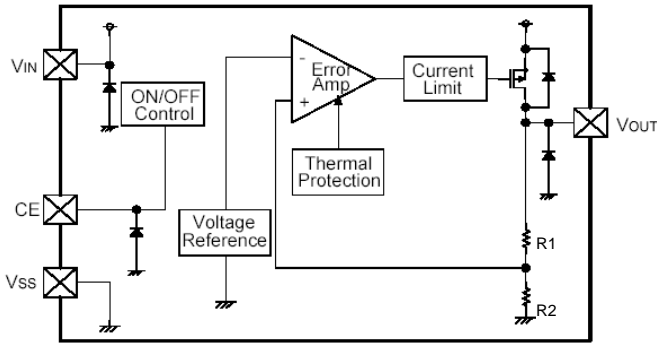
Ordering Information

XC6701 _____

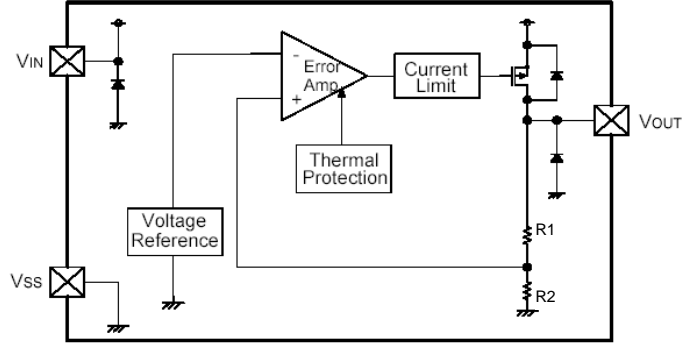
| DESIGNATOR | DESCRIPTION | SYMBOL | DESCRIPTION |
|------------|--------------------------------|----------|--|
| | Type and Options of Regulators | B | : Fixed output voltage with CE function (High Active) |
| | | D | : Fixed output voltage with no CE function |
| | Output Voltage | 18 ~ 99 | : For the voltage within 1.8V ~9.9V; e.g. 2.5V 25 5.0V 50 |
| | | A ~ H, J | : For the voltage above 10.0V; e.g. 11.6V B6 15.2V F2 18.0V J0 |
| | Output Voltage Accuracy | 2 | : Output voltage 100mV increments, within $\pm 2\%$ accuracy e.g. 2.5V =2, =5, =2 |
| | Packages | M | : SOT-25 (for B type only) |
| | | P | : SOT-89 (for D type only) |
| | | P | : SOT-89-5 (for B type only) |
| | | E | : USP-6C (for B type only) |
| | | F | : SOT-223 (for D type only) |
| | | J | : TO-252 (for D type only) |
| | Device Orientation | R | : Embossed tape, standard feed |
| | | L | : Embossed tape, reverse feed |

BLOCK DIAGRAMS

XC6701B Series
(SOT-25, SOT-89-5, USP-6C)



XC6701D Series
(SOT-89, SOT-223, TO-252)



ABSOLUTE MAXIMUM RATINGS

XC6701B Series

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|-----------------------------|----------|----------------------------|---|-------------------------------|
| Input Voltage | | V _{IN} | V _{SS} -0.3~30 | V |
| Output Current | | I _{OUT} | 300 ^{(*)1} | mA |
| Output Voltage | | V _{OUT} | V _{SS} -0.3~V _{IN} +0.3 | V |
| CE Input Voltage | | V _{CE} | V _{SS} -0.3~30 | V |
| Power Dissipation | SOT-25 | P _d | 250 | mW (T _J =25 °C) |
| | | | 600(wiring on the PCB) *2 | |
| | SOT-89-5 | | 500 | |
| | | | 1300(wiring on the PCB) *2 | |
| USP-6C | 100 | 1000(wiring on the PCB) *2 | | |
| Operating Temperature Range | | T _{opr} | -40~+85 | |
| Storage Temperature Range | | T _{stg} | -55~+125 | |

*1: $I_{OUT} \cdot P_d / (V_{IN} - V_{OUT})$

*2: The values of power dissipation is a reference data at wiring on the PCB. Please see the condition in page 27.

XC6701D Series

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|-----------------------------|---------|------------------|---|-------------------------------|
| Input Voltage | | V _{IN} | V _{SS} -0.3~30 | V |
| Output Current | | I _{OUT} | 300 ^{(*)1} | mA |
| Output Voltage | | V _{OUT} | V _{SS} -0.3~V _{IN} +0.3 | V |
| Power Dissipation | SOT-89 | P _d | 500 | mW (T _J =25 °C) |
| | SOT-223 | | 300 | |
| | TO-252 | | 1500(wiring on the PCB) *2 | |
| Operating Temperature Range | | T _{opr} | -40~+85 | |
| Storage Temperature Range | | T _{stg} | -55~+125 | |

*1: $I_{OUT} \cdot P_d / (V_{IN} - V_{OUT})$

*2: The values of power dissipation is a reference data at wiring on the PCB. Please see the condition in page 27.

ELECTRICAL CHARACTERISTICS

XC6701B Series

| PARAMETER | SYMBOL | CONDITIONS | Ta=+25 | | | UNIT | CIRCUIT |
|---|---|--|--------|-------|-----------------|------|---------|
| | | | MIN. | TYP. | MAX. | | |
| Output Voltage | V _{OUT(E)} | I _{OUT} =10mA, V _{CE} =V _{IN} | E-0 | | | V | |
| Maximum Output Current | I _{OUTMAX} | V _{IN} =V _{OUT(T)} +3.0V, V _{CE} =V _{IN} (V _{OUT(T)} > 3.0V) | 150 | - | - | mA | |
| | | V _{IN} =V _{OUT(T)} +3.0V, V _{CE} =V _{IN} (V _{OUT(T)} < 3.0V) | 100 | - | - | mA | |
| Load Regulation | V _{OUT} | 1mA I _{OUT} 50mA, V _{CE} =V _{IN} 1.8V V _{OUT(T)} 5.0V | - | 50 | 90 | mV | |
| | | 1mA I _{OUT} 50mA, V _{CE} =V _{IN} 5.1V V _{OUT(T)} 12.0V | - | 110 | 175 | | |
| | | 1mA I _{OUT} 50mA, V _{CE} =V _{IN} 12.1V V _{OUT(T)} 18.0V | - | 180 | 275 | | |
| Dropout Voltage 1 | V _{dif1} | I _{OUT} =20mA, V _{CE} =V _{IN} | E-2 | | | mV | |
| Dropout Voltage 2 | V _{dif2} | I _{OUT} =100mA, V _{CE} =V _{IN} | E-3 | | | mV | |
| Supply Current | I _{SS} | 1.8V V _{OUT(T)} 5.0V | 11 | 50 | 105 | μA | |
| | | 5.1V V _{OUT(T)} 12.0V | 11 | 60 | 115 | | |
| | | 12.1V V _{OUT(T)} 18.0V | 11 | 65 | 125 | | |
| Stand-by Current | I _{stby} | V _{CE} =V _{SS} | - | 0.01 | 0.10 | μA | |
| Line Regulation 1 | V _{OUT} / V _{IN} · V _{OUT(T)} | V _{OUT(T)} +2.0V V _{IN} 28.0V I _{OUT} =5mA, V _{CE} =V _{IN} | - | 0.05 | 0.10 | %/V | |
| Line Regulation 2 | V _{OUT} / V _{IN} · V _{OUT(T)} | V _{OUT(T)} +2.0V V _{IN} 28.0V I _{OUT} =13mA, V _{CE} =V _{IN} | - | 0.15 | 0.30 | %/V | |
| Input Voltage | V _{IN} | | 2.0 | - | 28.0 | V | - |
| Output Voltage Temperature Characteristics | V _{OUT} / Ta · V _{OUT(T)} | I _{OUT} =20mA, V _{CE} =V _{IN} -40 Ta 85 | - | ± 100 | - | ppm/ | |
| Ripple Rejection Rate | PSRR | V _{IN} =[V _{OUT(T)} +2.0V]+0.5V _{p-pAC} I _{OUT} =20mA, f=1kHz, V _{CE} =V _{IN} | - | 50 | - | dB | |
| Short Current | I _{short} | V _{IN} =V _{OUT(T)} +2.0V, V _{CE} =V _{IN} | - | 40 | - | mA | |
| CE "H" Level Voltage | V _{CEH} | V _{IN} =28.0V | 1.1 | - | V _{IN} | V | |
| CE "L" Level Voltage | V _{CEL} | V _{IN} =28.0V | 0 | - | 0.35 | V | |
| CE "H" Level Current | I _{CEH} | V _{IN} =V _{CE} =28.0V | -0.1 | - | 0.1 | μA | |
| CE "L" Level Current | I _{CEL} | V _{IN} =28.0V, V _{CE} =V _{SS} | -0.1 | - | 0.1 | μA | |
| Thermal Shutdown Detect Temperature | T _{TSD} | Junction Temperature | - | 150 | - | | |
| Thermal Shutdown Release Temperature | T _{TSR} | Junction Temperature | - | 125 | - | | |
| Hysteresis Width | T _{TSD} -T _{TSR} | Junction Temperature | - | 25 | - | | - |

NOTE:

*1: V_{OUT(T)}: Specified output voltage

*2: V_{OUT(E)}: Effective output voltage

(i.e. the output voltage when "V_{OUT(T)}+2.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.)

*3: V_{dif}={V_{IN1}(Note 5) - V_{OUT1}(Note 4)}

*4: V_{OUT1}: A voltage equal to 98% of the output voltage whenever an amply stabilized when V_{OUT(T)} < 3.0V, I_{OUT}{V_{OUT(T)}+3.0V} is input.
: A voltage equal to 98% of the output voltage whenever an amply stabilized when V_{OUT(T)} > 3.0V, I_{OUT}{V_{OUT(T)}+2.0V} is input.

*5: V_{IN1}: The input voltage when V_{OUT1} appears as input voltage is gradually decreased.

*6: Unless otherwise stated, V_{IN}=V_{OUT(T)}+2.0V.

ELECTRICAL CHARACTERISTICS (Continued)

XC6701D Series

| PARAMETER | SYMBOL | CONDITIONS | Ta=+25 | | | UNIT | CIRCUIT |
|---|-------------------------|--|--------|-------|------|------|---------|
| | | | MIN. | TYP. | MAX. | | |
| Output Voltage | VOUT(E) | IOUT=10mA | E-0 | | | V | |
| Maximum Output Current | IOUTMAX | VIN= VOUT(T)+3.0V (VOUT(T) 3.0V) | 150 | - | - | mA | |
| | | VIN=VOUT(T)+3.0V (VOUT(T) < 3.0V) | 100 | - | - | mA | |
| Load Regulation | VOUT | 1mA IOUT 50mA 1.8V VOUT(T) 5.0V | - | 50 | 90 | mV | |
| | | 1mA IOUT 50mA 5.1V VOUT(T) 12.0V | - | 110 | 175 | | |
| | | 1mA IOUT 50mA 12.1V VOUT(T) 18.0V | - | 180 | 275 | | |
| Dropout Voltage1 | Vdif1 | IOUT=20mA | E-2 | | | mV | |
| Dropout Voltage2 | Vdif2 | IOUT =100mA , VCE=VIN | E-3 | | | mV | |
| Supply Current | ISS | 1.8V VOUT(T) 5.0V | 11 | 50 | 105 | μA | |
| | | 5.1V VOUT(T) 12.0V | 11 | 60 | 115 | μA | |
| | | 12.1V VOUT(T) 18.0V | 11 | 65 | 125 | | |
| Line Regulation1 | VOUT / VIN · VOUT(T) | VOUT(T)+2.0V VIN 28.0V IOUT=5mA | - | 0.05 | 0.10 | %/V | |
| Line Regulation2 | VOUT / VIN · VOUT(T) | VOUT(T)+2.0V VIN 28.0V IOUT=13mA | - | 0.15 | 0.30 | %/V | |
| Input Voltage | VIN | | 2.0 | - | 28.0 | V | - |
| Output Voltage Temperature Characteristics | VOUT / Ta · VOUT(T) | IOUT=20mA -40 Ta 85 | - | ± 100 | - | ppm/ | |
| Ripple Rejection Rate | PSRR | VIN=[VOUT(T)+2.0V]+0.5Vp-pAC IOUT=20mA , f=1kHz | - | 50 | - | dB | |
| Short Current | Ishort | VIN=VOUT(T)+2.0V | - | 40 | - | mA | |
| Thermal Shutdown Detect Temperature | TTSD | Junction Temperature | - | 150 | - | | |
| Thermal Shutdown Release Temperature | TTSR | Junction Temperature | - | 125 | - | | |
| Hysteresis Width | TTSD-TTSR | Junction Temperature | - | 25 | - | | - |

NOTE:

*1: VOUT(T): Specified output voltage

*2: VOUT(E): Effective output voltage

(i.e. the output voltage when "VOUT(T)+2.0V" is provided at the VIN pin while maintaining a certain IOUT value.)

*3: $Vdif = \{V_{IN1}^{(Note\ 5)} - V_{OUT1}^{(Note\ 4)}\}$

*4: VOUT1: A voltage equal to 98% of the output voltage whenever an amply stabilized when VOUT(T) < 3.0V, IOUT{VOUT(T)+3.0V} is input.

: A voltage equal to 98% of the output voltage whenever an amply stabilized when VOUT(T) 3.0V, IOUT{VOUT(T)+2.0V} is input.

*5: VIN1: The input voltage when VOUT1 appears as input voltage is gradually decreased.

*6: Unless otherwise stated, VIN=VOUT(T)+2.0V.

ELECTRICAL CHARACTERISTICS (Continued)

Voltage Chart

| SYMBOL | E-0 | | E-2 | | E-3 | |
|----------------------------------|---------------------------------------|-------|---|------|--|------|
| PARAMETER | OUTPUT VOLTAGE (V) (2% products) | | DROPOUT VOLTAGE 1 (mV) $I_{OUT}=20mA$ | | DROPOUT VOLTAGE 2 (mV) $I_{OUT}=100mA$ | |
| SETTING OUTPUT VOLTAGE (V) | V_{OUT} | | V_{dif1} | | V_{dif2} | |
| $V_{OUT(T)}$ (V) | MIN. | MAX. | TYP. | MAX. | TYP. | MAX. |
| 1.8 | 1.764 | 1.836 | 550 | 710 | 2200 | 2700 |
| 1.9 | 1.862 | 1.938 | 550 | 710 | 2200 | 2700 |
| 2.0 | 1.960 | 2.040 | 450 | 600 | 1900 | 2600 |
| 2.1 | 2.058 | 2.142 | 450 | 600 | 1900 | 2600 |
| 2.2 | 2.156 | 2.244 | 390 | 520 | 1700 | 2200 |
| 2.3 | 2.254 | 2.346 | 390 | 520 | 1700 | 2200 |
| 2.4 | 2.352 | 2.448 | 390 | 520 | 1700 | 2200 |
| 2.5 | 2.450 | 2.550 | 310 | 450 | 1500 | 1900 |
| 2.6 | 2.548 | 2.652 | 310 | 450 | 1500 | 1900 |
| 2.7 | 2.646 | 2.754 | 310 | 450 | 1500 | 1900 |
| 2.8 | 2.744 | 2.856 | 310 | 450 | 1500 | 1900 |
| 2.9 | 2.842 | 2.958 | 310 | 450 | 1500 | 1900 |
| 3.0 | 2.940 | 3.060 | 260 | 360 | 1300 | 1700 |
| 3.1 | 3.038 | 3.162 | 260 | 360 | 1300 | 1700 |
| 3.2 | 3.136 | 3.264 | 260 | 360 | 1300 | 1700 |
| 3.3 | 3.234 | 3.366 | 260 | 360 | 1300 | 1700 |
| 3.4 | 3.332 | 3.468 | 260 | 360 | 1300 | 1700 |
| 3.5 | 3.430 | 3.570 | 260 | 360 | 1300 | 1700 |
| 3.6 | 3.528 | 3.672 | 260 | 360 | 1300 | 1700 |
| 3.7 | 3.626 | 3.774 | 260 | 360 | 1300 | 1700 |
| 3.8 | 3.724 | 3.876 | 260 | 360 | 1300 | 1700 |
| 3.9 | 3.822 | 3.978 | 260 | 360 | 1300 | 1700 |
| 4.0 | 3.920 | 4.080 | 220 | 320 | 1100 | 1500 |
| 4.1 | 4.018 | 4.182 | 220 | 320 | 1100 | 1500 |
| 4.2 | 4.116 | 4.284 | 220 | 320 | 1100 | 1500 |
| 4.3 | 4.214 | 4.386 | 220 | 320 | 1100 | 1500 |
| 4.4 | 4.312 | 4.488 | 220 | 320 | 1100 | 1500 |
| 4.5 | 4.410 | 4.590 | 220 | 320 | 1100 | 1500 |
| 4.6 | 4.508 | 4.692 | 220 | 320 | 1100 | 1500 |
| 4.7 | 4.606 | 4.794 | 220 | 320 | 1100 | 1500 |
| 4.8 | 4.704 | 4.896 | 220 | 320 | 1100 | 1500 |
| 4.9 | 4.802 | 4.998 | 220 | 320 | 1100 | 1500 |
| 5.0 | 4.900 | 5.100 | 190 | 280 | 1000 | 1300 |
| 5.1 | 4.998 | 5.202 | 190 | 280 | 1000 | 1300 |
| 5.2 | 5.096 | 5.304 | 190 | 280 | 1000 | 1300 |
| 5.3 | 5.194 | 5.406 | 190 | 280 | 1000 | 1300 |
| 5.4 | 5.292 | 5.508 | 190 | 280 | 1000 | 1300 |
| 5.5 | 5.390 | 5.610 | 190 | 280 | 1000 | 1300 |
| 5.6 | 5.488 | 5.712 | 190 | 280 | 1000 | 1300 |
| 5.7 | 5.586 | 5.814 | 190 | 280 | 1000 | 1300 |
| 5.8 | 5.684 | 5.916 | 190 | 280 | 1000 | 1300 |
| 5.9 | 5.782 | 6.018 | 190 | 280 | 1000 | 1300 |
| 6.0 | 5.880 | 6.120 | 190 | 280 | 1000 | 1300 |

ELECTRICAL CHARACTERISTICS (Continued)

Voltage Chart (Continued)

| SYMBOL | E-0 | | E-2 | | E-3 | |
|----------------------------------|---------------------------------------|--------|---|------|--|------|
| PARAMETER | OUTPUT VOLTAGE (V) (2% products) | | DROPOUT VOLTAGE 1 (mV) $I_{OUT}=20mA$ | | DROPOUT VOLTAGE 2 (mV) $I_{OUT}=100mA$ | |
| SETTING OUTPUT VOLTAGE (V) | V_{OUT} | | V_{dif1} | | V_{dif2} | |
| $V_{OUT(T)}$ (V) | MIN. | MAX. | TYP. | MAX. | TYP. | MAX. |
| 6.1 | 5.978 | 6.222 | 190 | 280 | 1000 | 1300 |
| 6.2 | 6.076 | 6.324 | 190 | 280 | 1000 | 1300 |
| 6.3 | 6.174 | 6.426 | 190 | 280 | 1000 | 1300 |
| 6.4 | 6.272 | 6.528 | 190 | 280 | 1000 | 1300 |
| 6.5 | 6.370 | 6.630 | 170 | 230 | 800 | 1150 |
| 6.6 | 6.468 | 6.732 | 170 | 230 | 800 | 1150 |
| 6.7 | 6.566 | 6.834 | 170 | 230 | 800 | 1150 |
| 6.8 | 6.664 | 6.936 | 170 | 230 | 800 | 1150 |
| 6.9 | 6.762 | 7.038 | 170 | 230 | 800 | 1150 |
| 7.0 | 6.860 | 7.140 | 170 | 230 | 800 | 1150 |
| 7.1 | 6.958 | 7.242 | 170 | 230 | 800 | 1150 |
| 7.2 | 7.056 | 7.344 | 170 | 230 | 800 | 1150 |
| 7.3 | 7.154 | 7.446 | 170 | 230 | 800 | 1150 |
| 7.4 | 7.252 | 7.548 | 170 | 230 | 800 | 1150 |
| 7.5 | 7.350 | 7.650 | 170 | 230 | 800 | 1150 |
| 7.6 | 7.448 | 7.752 | 170 | 230 | 800 | 1150 |
| 7.7 | 7.546 | 7.854 | 170 | 230 | 800 | 1150 |
| 7.8 | 7.644 | 7.956 | 170 | 230 | 800 | 1150 |
| 7.9 | 7.742 | 8.058 | 170 | 230 | 800 | 1150 |
| 8.0 | 7.840 | 8.160 | 170 | 230 | 800 | 1150 |
| 8.1 | 7.938 | 8.262 | 130 | 190 | 700 | 950 |
| 8.2 | 8.036 | 8.364 | 130 | 190 | 700 | 950 |
| 8.3 | 8.134 | 8.466 | 130 | 190 | 700 | 950 |
| 8.4 | 8.232 | 8.568 | 130 | 190 | 700 | 950 |
| 8.5 | 8.330 | 8.670 | 130 | 190 | 700 | 950 |
| 8.6 | 8.428 | 8.772 | 130 | 190 | 700 | 950 |
| 8.7 | 8.526 | 8.874 | 130 | 190 | 700 | 950 |
| 8.8 | 8.624 | 8.976 | 130 | 190 | 700 | 950 |
| 8.9 | 8.722 | 9.078 | 130 | 190 | 700 | 950 |
| 9.0 | 8.820 | 9.180 | 130 | 190 | 700 | 950 |
| 9.1 | 8.918 | 9.282 | 130 | 190 | 700 | 950 |
| 9.2 | 9.016 | 9.384 | 130 | 190 | 700 | 950 |
| 9.3 | 9.114 | 9.486 | 130 | 190 | 700 | 950 |
| 9.4 | 9.212 | 9.588 | 130 | 190 | 700 | 950 |
| 9.5 | 9.310 | 9.690 | 130 | 190 | 700 | 950 |
| 9.6 | 9.408 | 9.792 | 130 | 190 | 700 | 950 |
| 9.7 | 9.506 | 9.894 | 130 | 190 | 700 | 950 |
| 9.8 | 9.604 | 9.996 | 130 | 190 | 700 | 950 |
| 9.9 | 9.702 | 10.098 | 130 | 190 | 700 | 950 |
| 10.0 | 9.800 | 10.200 | 130 | 190 | 700 | 950 |

ELECTRICAL CHARACTERISTICS (Continued)

Voltage Chart (Continued)

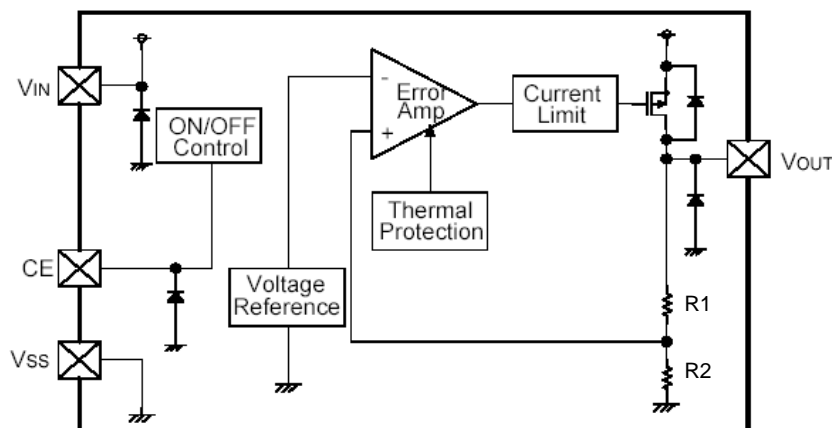
| SYMBOL | E-0 | | E-1 | | E-2 | |
|----------------------------------|---------------------------------------|--------|---|------|--|------|
| PARAMETER | OUTPUT VOLTAGE (V) (2% products) | | DROPOUT VOLTAGE 1 (mV) $I_{OUT}=20mA$ | | DROPOUT VOLTAGE 2 (mV) $I_{OUT}=100mA$ | |
| SETTING OUTPUT VOLTAGE (V) | V_{OUT} | | V_{dif1} | | V_{dif2} | |
| $V_{OUT(T)}$ (V) | MIN. | MAX. | TYP. | MAX. | TYP. | MAX. |
| 10.1 | 9.898 | 10.302 | 120 | 170 | 650 | 850 |
| 10.2 | 9.996 | 10.404 | 120 | 170 | 650 | 850 |
| 10.3 | 10.094 | 10.506 | 120 | 170 | 650 | 850 |
| 10.4 | 10.192 | 10.608 | 120 | 170 | 650 | 850 |
| 10.5 | 10.290 | 10.710 | 120 | 170 | 650 | 850 |
| 10.6 | 10.388 | 10.812 | 120 | 170 | 650 | 850 |
| 10.7 | 10.486 | 10.914 | 120 | 170 | 650 | 850 |
| 10.8 | 10.584 | 11.016 | 120 | 170 | 650 | 850 |
| 10.9 | 10.682 | 11.118 | 120 | 170 | 650 | 850 |
| 11.0 | 10.780 | 11.220 | 120 | 170 | 650 | 850 |
| 11.1 | 10.878 | 11.322 | 120 | 170 | 650 | 850 |
| 11.2 | 10.976 | 11.424 | 120 | 170 | 650 | 850 |
| 11.3 | 11.074 | 11.526 | 120 | 170 | 650 | 850 |
| 11.4 | 11.172 | 11.628 | 120 | 170 | 650 | 850 |
| 11.5 | 11.270 | 11.730 | 120 | 170 | 650 | 850 |
| 11.6 | 11.368 | 11.832 | 120 | 170 | 650 | 850 |
| 11.7 | 11.466 | 11.934 | 120 | 170 | 650 | 850 |
| 11.8 | 11.564 | 12.036 | 120 | 170 | 650 | 850 |
| 11.9 | 11.662 | 12.138 | 120 | 170 | 650 | 850 |
| 12.0 | 11.760 | 12.240 | 120 | 170 | 650 | 850 |
| 12.1 | 11.858 | 12.342 | 120 | 170 | 650 | 850 |
| 12.2 | 11.956 | 12.444 | 120 | 170 | 650 | 850 |
| 12.3 | 12.054 | 12.546 | 120 | 170 | 650 | 850 |
| 12.4 | 12.152 | 12.648 | 120 | 170 | 650 | 850 |
| 12.5 | 12.250 | 12.750 | 120 | 170 | 650 | 850 |
| 12.6 | 12.348 | 12.852 | 120 | 170 | 650 | 850 |
| 12.7 | 12.446 | 12.954 | 120 | 170 | 650 | 850 |
| 12.8 | 12.544 | 13.056 | 120 | 170 | 650 | 850 |
| 12.9 | 12.642 | 13.158 | 120 | 170 | 650 | 850 |
| 13.0 | 12.740 | 13.260 | 120 | 170 | 650 | 850 |
| 13.1 | 12.838 | 13.362 | 120 | 170 | 650 | 850 |
| 13.2 | 12.936 | 13.464 | 120 | 170 | 650 | 850 |
| 13.3 | 13.034 | 13.566 | 120 | 170 | 650 | 850 |
| 13.4 | 13.132 | 13.668 | 120 | 170 | 650 | 850 |
| 13.5 | 13.230 | 13.770 | 120 | 170 | 650 | 850 |
| 13.6 | 13.328 | 13.872 | 120 | 170 | 650 | 850 |
| 13.7 | 13.426 | 13.974 | 120 | 170 | 650 | 850 |
| 13.8 | 13.524 | 14.076 | 120 | 170 | 650 | 850 |
| 13.9 | 13.622 | 14.178 | 120 | 170 | 650 | 850 |
| 14.0 | 13.720 | 14.280 | 120 | 170 | 650 | 850 |

OUTPUT VOLTAGE CHART (Continued)

Voltage Chart (Continued)

| SYMBOL | E-0 | | E-1 | | E-2 | |
|----------------------------------|---------------------------------------|--------|---|------|--|------|
| PARAMETER | OUTPUT VOLTAGE (V) (2% products) | | DROPOUT VOLTAGE 1 (mV) $I_{OUT}=20mA$ | | DROPOUT VOLTAGE 2 (mV) $I_{OUT}=100mA$ | |
| SETTING OUTPUT VOLTAGE (V) | V_{OUT} | | V_{dif1} | | V_{dif2} | |
| $V_{OUT(T)}$ (V) | MIN. | MAX. | TYP. | MAX. | TYP. | MAX. |
| 14.1 | 13.818 | 14.382 | 120 | 170 | 650 | 850 |
| 14.2 | 13.916 | 14.484 | 120 | 170 | 650 | 850 |
| 14.3 | 14.014 | 14.586 | 120 | 170 | 650 | 850 |
| 14.4 | 14.112 | 14.688 | 120 | 170 | 650 | 850 |
| 14.5 | 14.210 | 14.790 | 120 | 170 | 650 | 850 |
| 14.6 | 14.308 | 14.892 | 120 | 170 | 650 | 850 |
| 14.7 | 14.406 | 14.994 | 120 | 170 | 650 | 850 |
| 14.8 | 14.504 | 15.096 | 120 | 170 | 650 | 850 |
| 14.9 | 14.602 | 15.198 | 120 | 170 | 650 | 850 |
| 15.0 | 14.700 | 15.300 | 120 | 170 | 650 | 850 |
| 15.1 | 14.798 | 15.402 | 120 | 170 | 650 | 850 |
| 15.2 | 14.896 | 15.504 | 120 | 170 | 650 | 850 |
| 15.3 | 14.994 | 15.606 | 120 | 170 | 650 | 850 |
| 15.4 | 15.092 | 15.708 | 120 | 170 | 650 | 850 |
| 15.5 | 15.190 | 15.810 | 120 | 170 | 650 | 850 |
| 15.6 | 15.288 | 15.912 | 120 | 170 | 650 | 850 |
| 15.7 | 15.386 | 16.014 | 120 | 170 | 650 | 850 |
| 15.8 | 15.484 | 16.116 | 120 | 170 | 650 | 850 |
| 15.9 | 15.582 | 16.218 | 120 | 170 | 650 | 850 |
| 16.0 | 15.680 | 16.320 | 120 | 170 | 650 | 850 |
| 16.1 | 15.778 | 16.422 | 120 | 170 | 650 | 850 |
| 16.2 | 15.876 | 16.524 | 120 | 170 | 650 | 850 |
| 16.3 | 15.974 | 16.626 | 120 | 170 | 650 | 850 |
| 16.4 | 16.072 | 16.728 | 120 | 170 | 650 | 850 |
| 16.5 | 16.170 | 16.830 | 120 | 170 | 650 | 850 |
| 16.6 | 16.268 | 16.932 | 120 | 170 | 650 | 850 |
| 16.7 | 16.366 | 17.034 | 120 | 170 | 650 | 850 |
| 16.8 | 16.464 | 17.136 | 120 | 170 | 650 | 850 |
| 16.9 | 16.562 | 17.238 | 120 | 170 | 650 | 850 |
| 17.0 | 16.660 | 17.340 | 120 | 170 | 650 | 850 |
| 17.1 | 16.758 | 17.442 | 120 | 170 | 650 | 850 |
| 17.2 | 16.856 | 17.544 | 120 | 170 | 650 | 850 |
| 17.3 | 16.954 | 17.646 | 120 | 170 | 650 | 850 |
| 17.4 | 17.052 | 17.748 | 120 | 170 | 650 | 850 |
| 17.5 | 17.150 | 17.850 | 120 | 170 | 650 | 850 |
| 17.6 | 17.248 | 17.952 | 120 | 170 | 650 | 850 |
| 17.7 | 17.346 | 18.054 | 120 | 170 | 650 | 850 |
| 17.8 | 17.444 | 18.156 | 120 | 170 | 650 | 850 |
| 17.9 | 17.542 | 18.258 | 120 | 170 | 650 | 850 |
| 18.0 | 17.640 | 18.360 | 120 | 170 | 650 | 850 |

OPERATIONAL EXPLANATION



<Output Voltage Control>

The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET, which is connected to the VOUT pin, is then driven by the subsequent output signal. The output voltage at the VOUT pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current and heat dissipation. Further, the IC's internal circuitry can be shutdown via the CE pin's signal.

<Short-Circuit Protection>

The XC6701 series includes a current fold-back circuit as a short circuit protection. When the load current reaches the current limit level, the current fold-back circuit operates and output voltage drops. The output voltage drops further and output current decreases. When the output pin is shorted, a current of about 30mA flows.

<CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin with the XC6701B series. In shutdown mode, output at the VOUT pin will be pulled down by R1 and R2 to the VSS level. Note that as the XC6701B series' operations will become unstable with the CE pin open. We suggest that you use this IC with either a VIN voltage or a VSS voltage input at the CE pin. If this IC is used with the correct specifications for the CE pin, the operational logic is fixed and the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry if a medium voltage is applied.

<Thermal Shutdown>

When the junction temperature of the built-in driver transistor reaches the temperature limit level (150 TYP.), the thermal shutdown circuit operates and the driver transistor will be set to OFF. The IC resumes its operation when the thermal shutdown function is released and the IC's operation is automatically restored because the junction temperature drops to the level of the thermal shutdown release voltage.

<Minimum Operating Voltage>

For the stable operation of the IC, over 2.0V of input voltage is necessary. The output voltage may not be generated normally if the input voltage is less than 2.0V.

NOTES ON USE

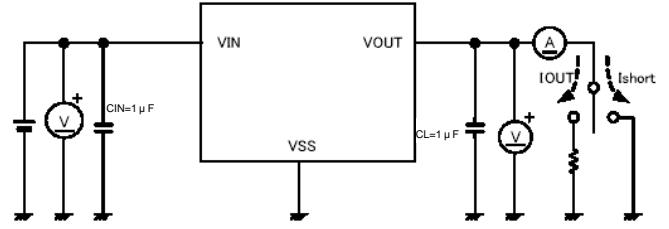
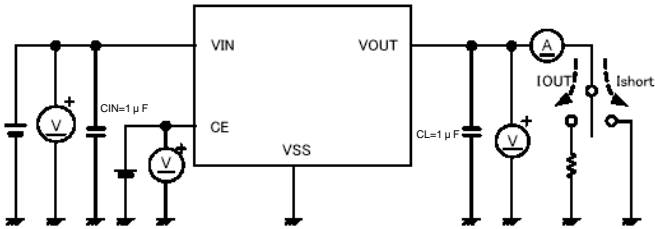
1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.
2. Where wiring impedance is high, operations may become unstable due to the noise and/or phase lag depending on output current. Please strengthen VIN and VSS wiring in particular.
3. Phase compensation inside the IC is performed in the XC6701 series. Therefore, an abnormal oscillation does not occur even if there is no output capacitor CL. An input capacitor CIN around 0.1 μF~1.0 μF between the VIN pin and the VSS pin is required for input stability. Also, the output voltage fluctuation such as under shoot or over shoot, which occurs because of the load change can be controlled by placing the output capacitor CL around 0.1 μF~1.0 μF between the VOUT pin and VSS pin. The input capacitor (CIN) and the output capacitor (CL) should be placed to the IC as close as possible with a shorter wiring.
4. When the IC is operated with no load, the output voltage may increase in the high temperature beyond operating range.

TEST CIRCUITS

Circuit

XC6701B Series

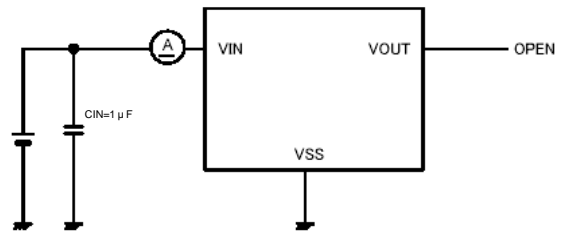
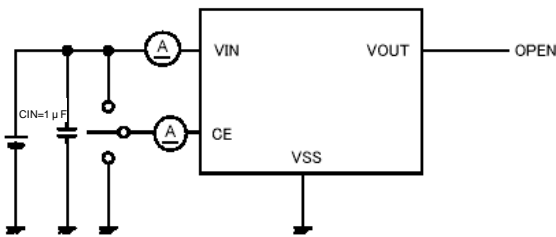
XC6701D Series



Circuit

XC6701B Series

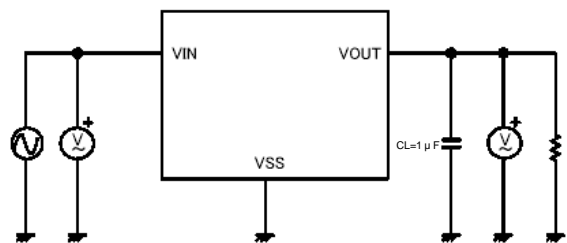
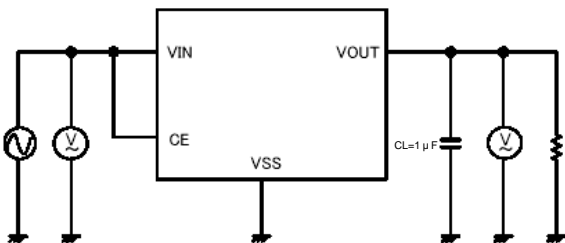
XC6701D Series



Circuit

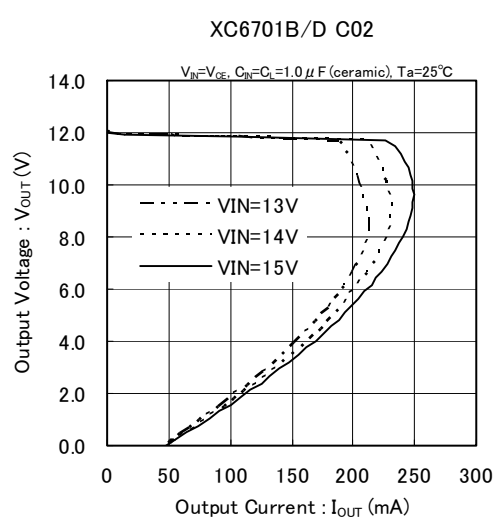
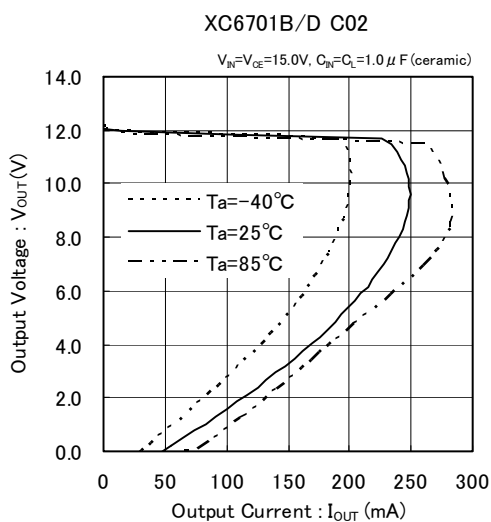
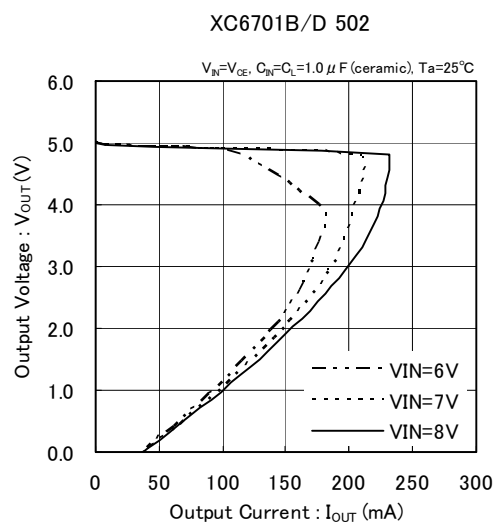
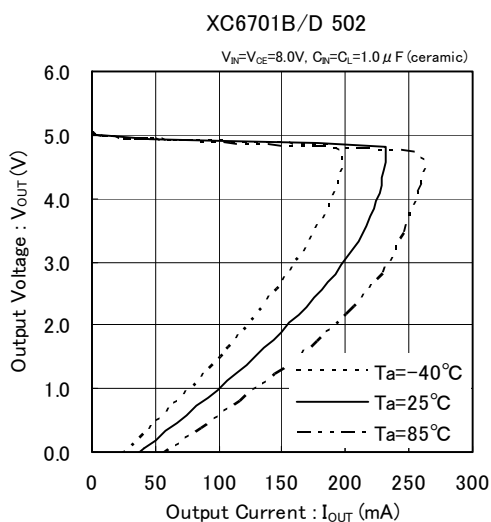
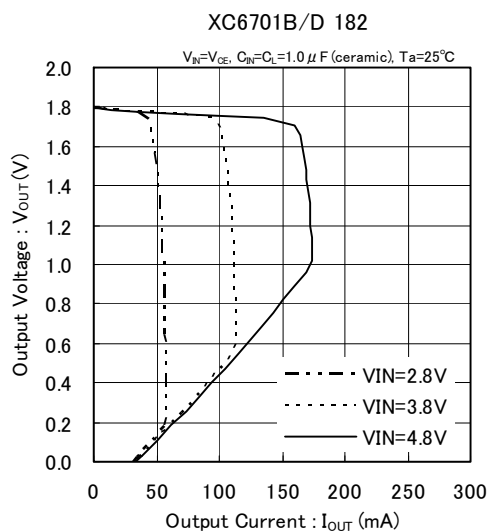
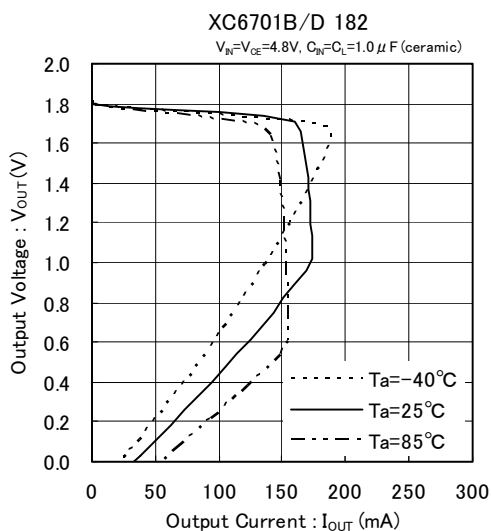
XC6701B Series

XC6701D Series



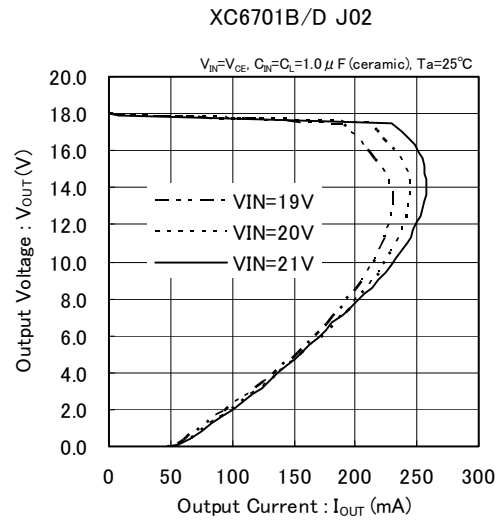
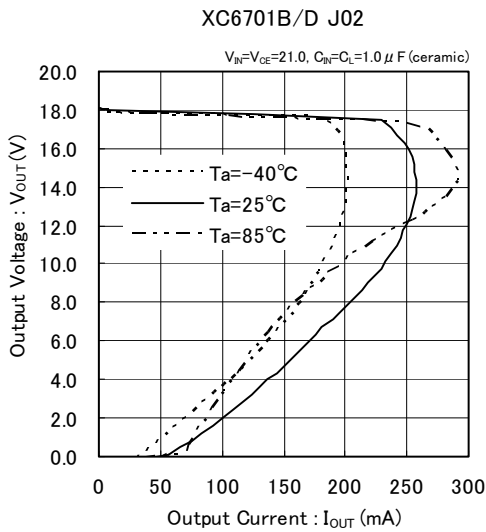
TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current

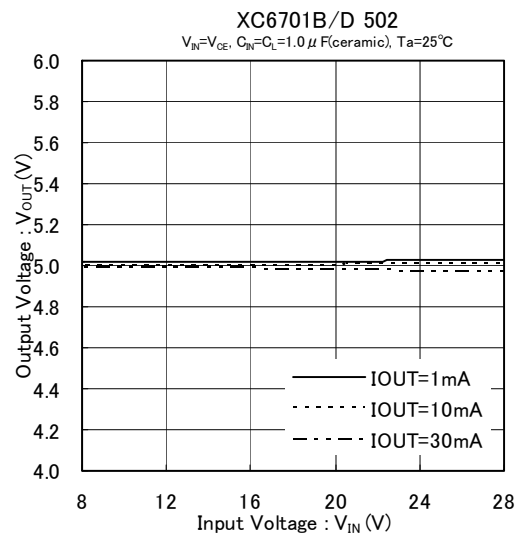
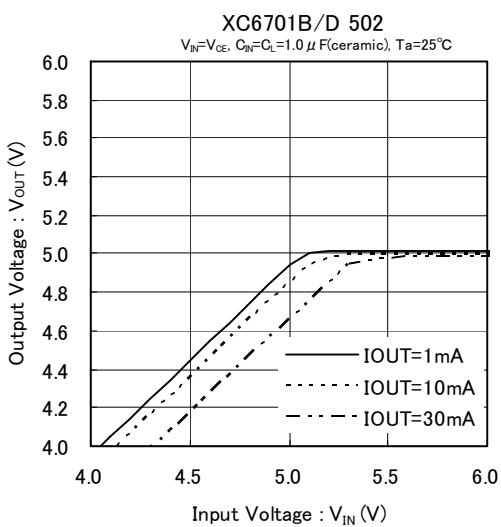
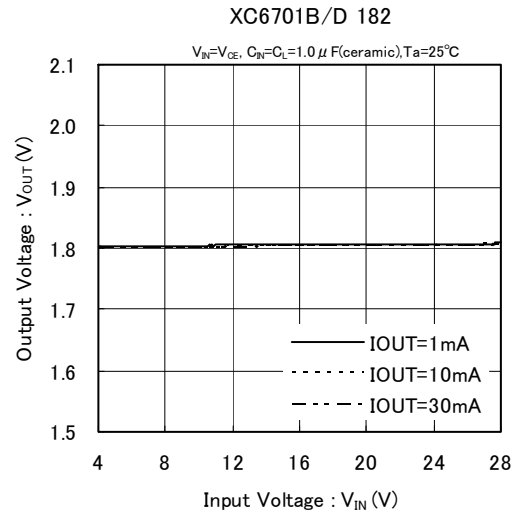
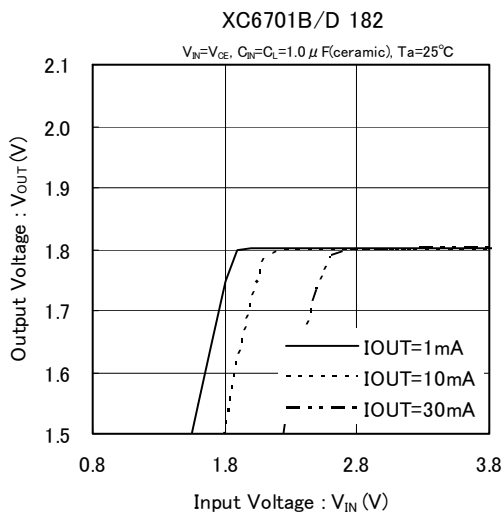


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(1) Output Voltage vs. Output Current (Continued)

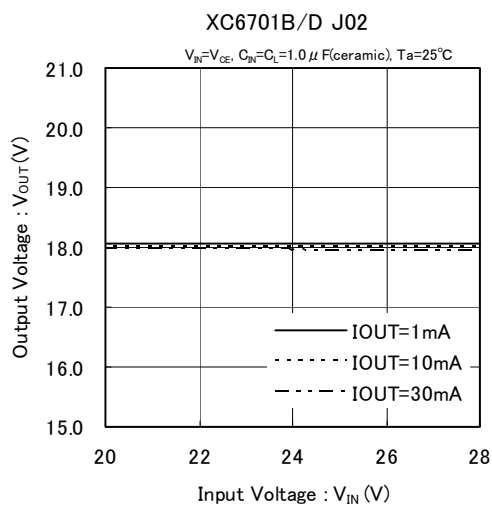
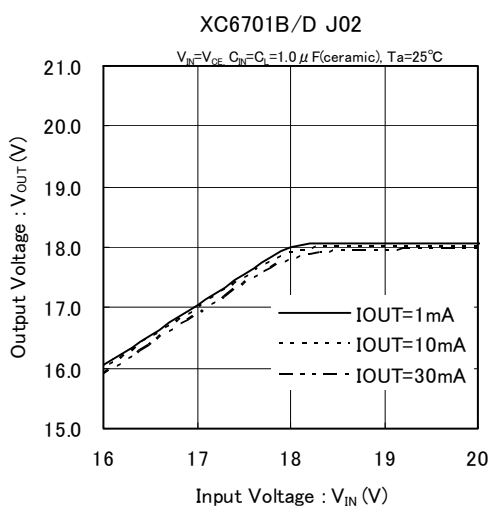
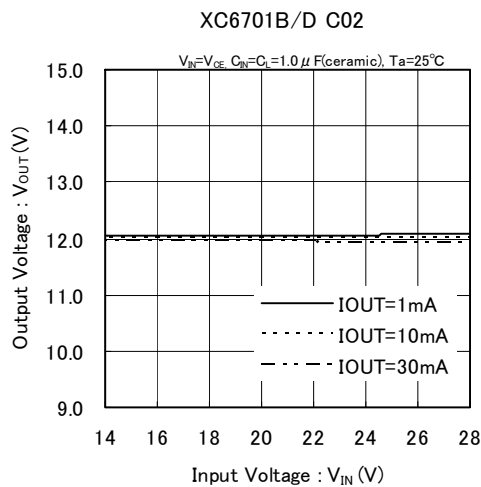
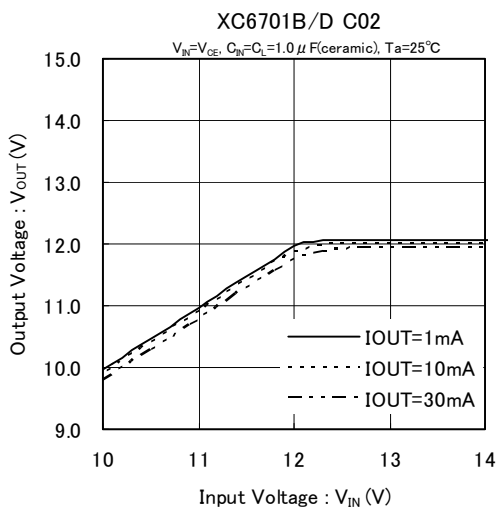


(2) Output Voltage vs. Input Voltage

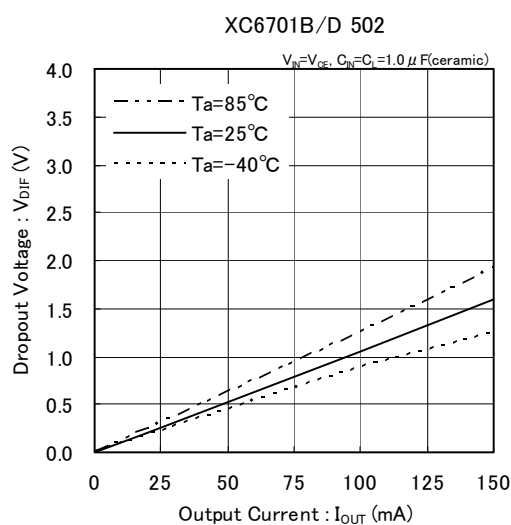
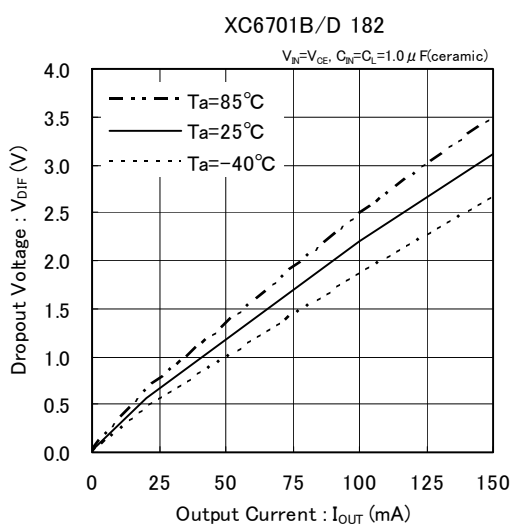


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage (Continued)

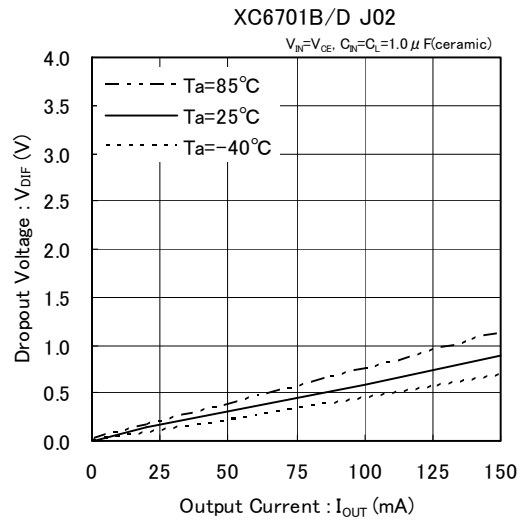
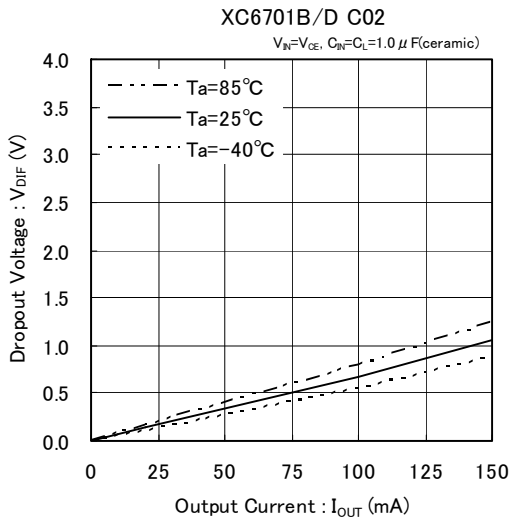


(3) Dropout Voltage vs. Output Current

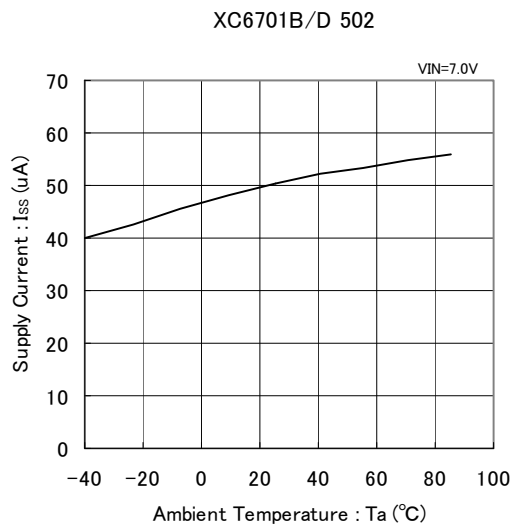
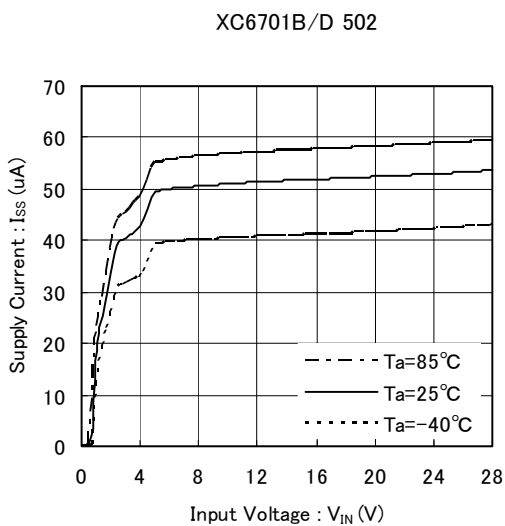
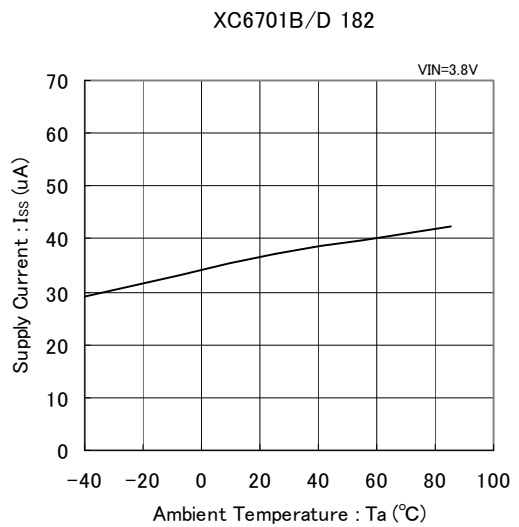
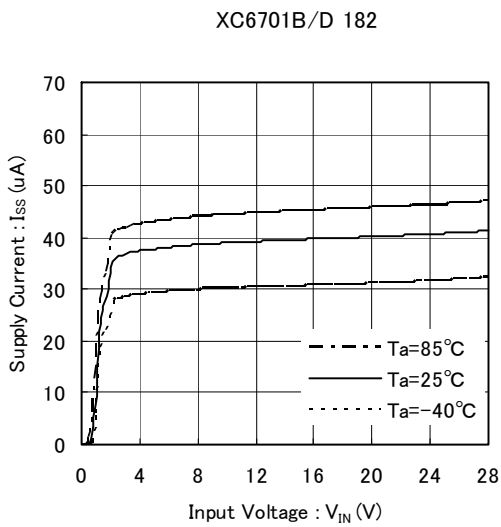


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current (Continued)



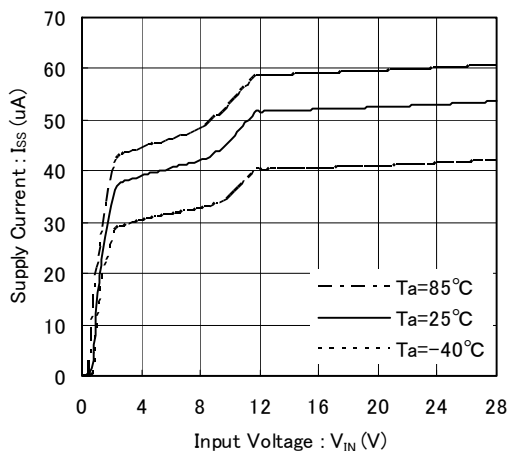
(4) Supply Current vs. Input Voltage



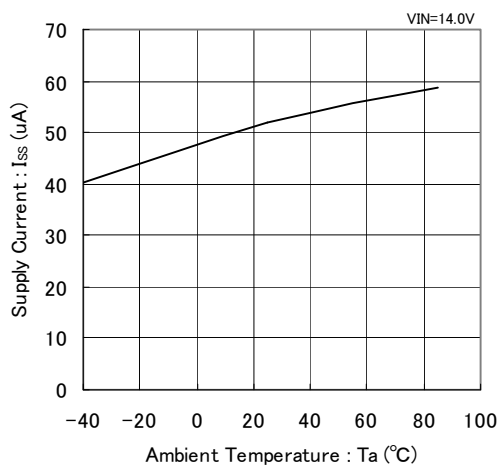
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(4) Supply Current vs. Input Voltage (Continued)

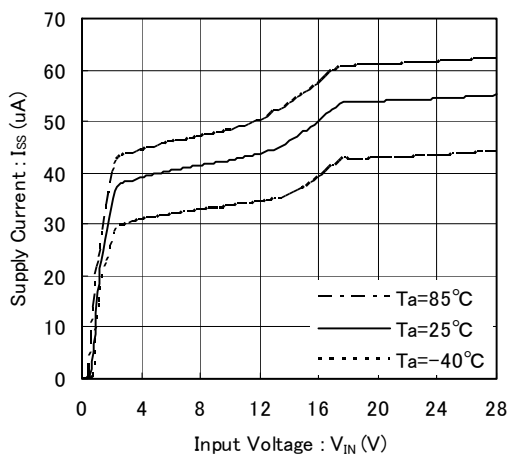
XC6701B/D C02



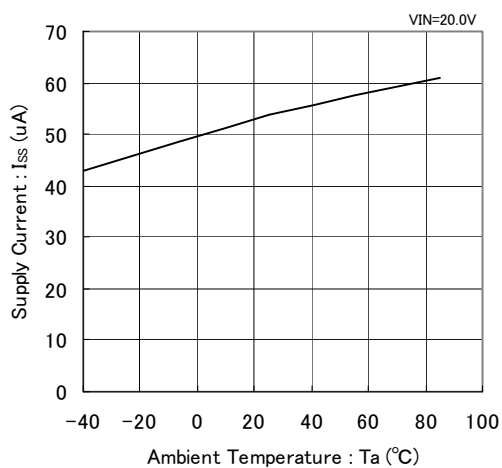
XC6701B/D C02



XC6701B/D J02



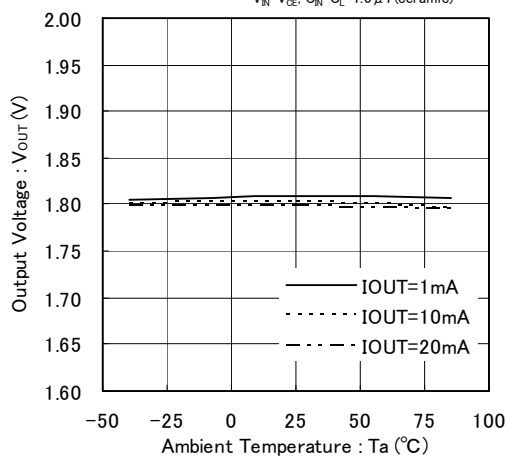
XC6701B/D J02



(5) Output Voltage vs. Ambient Temperature

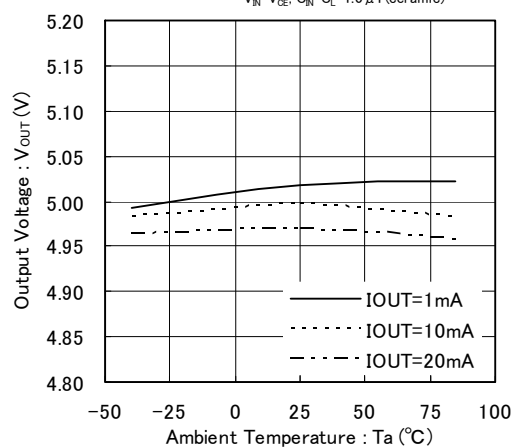
XC6701B/D 182

$V_{IN}=V_{CE}$, $C_{IN}=C_L=1.0\ \mu\text{F}$ (ceramic)



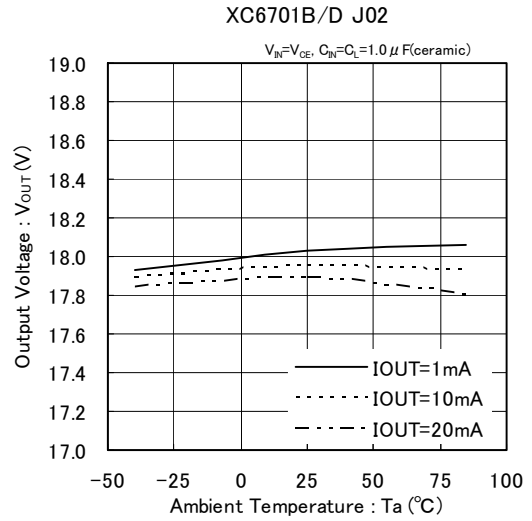
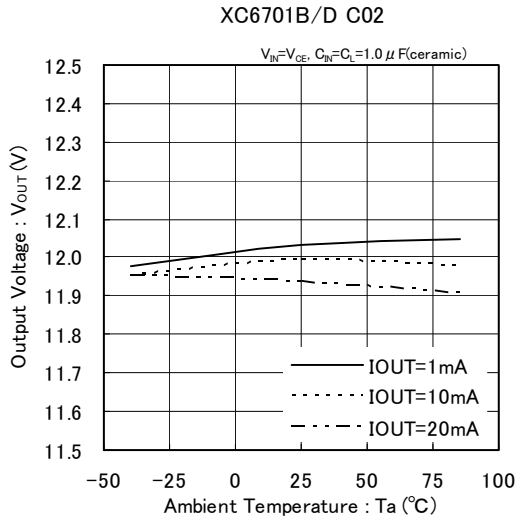
XC6701B/D 502

$V_{IN}=V_{CE}$, $C_{IN}=C_L=1.0\ \mu\text{F}$ (ceramic)

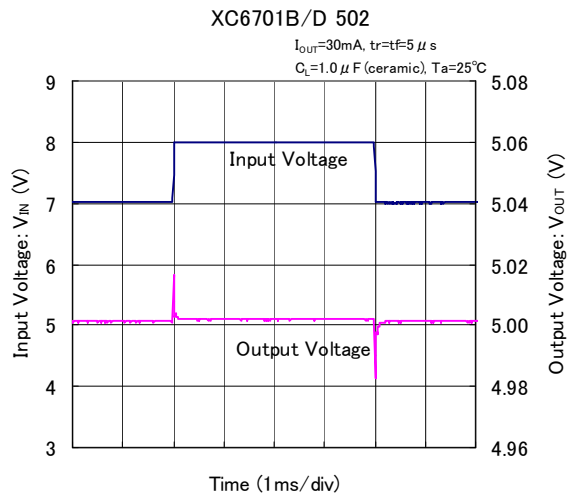
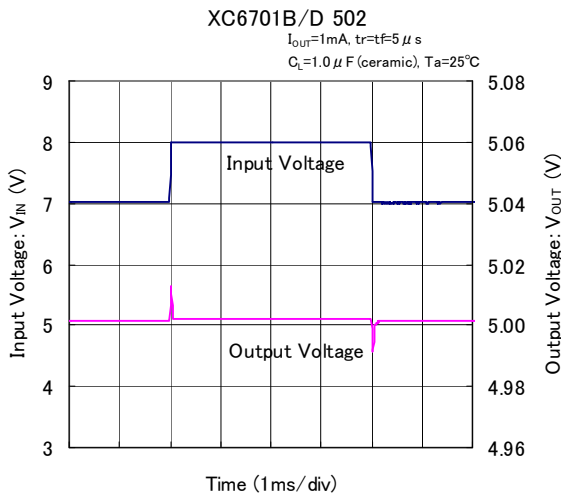
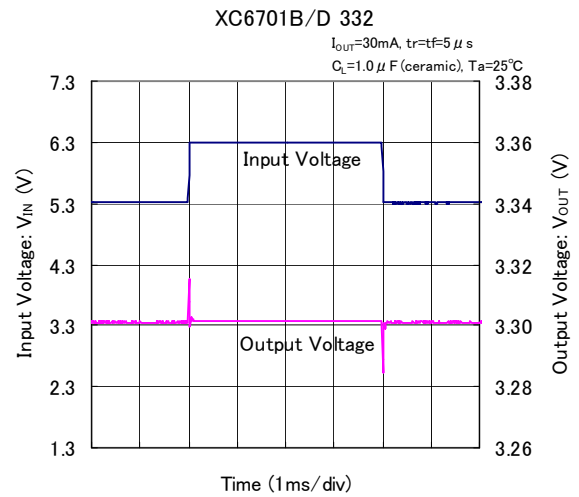
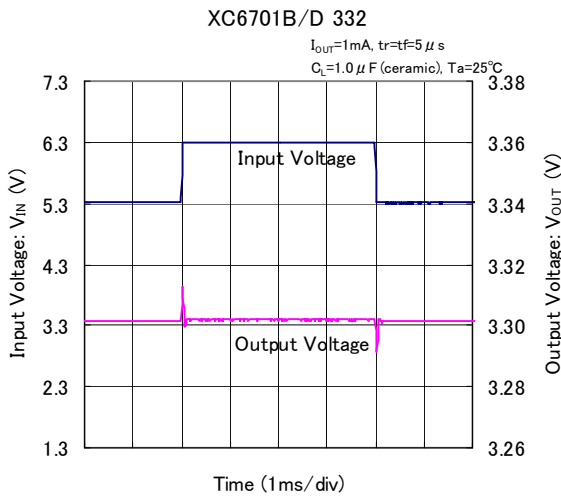


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Output Voltage vs. Ambient Temperature (Continued)

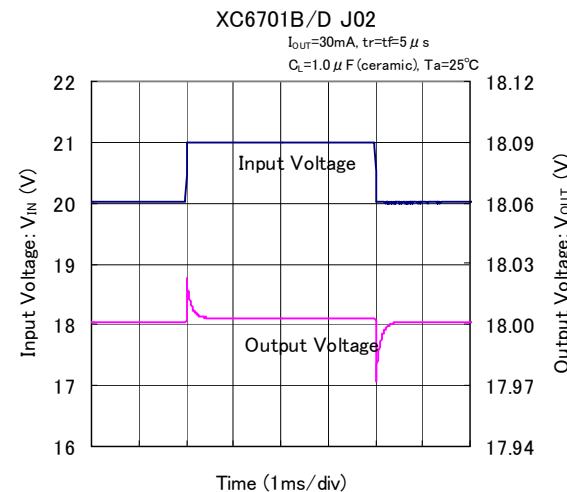
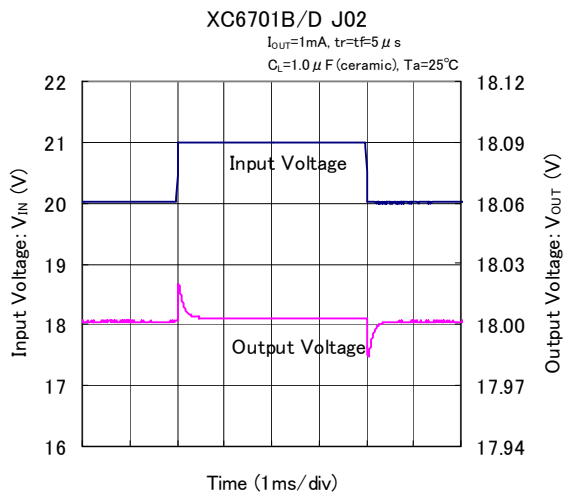
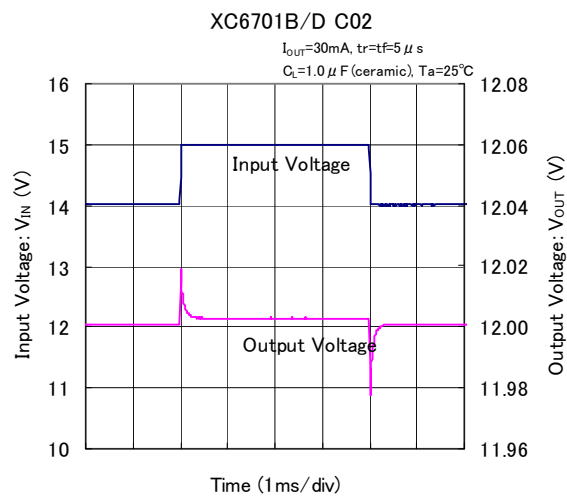
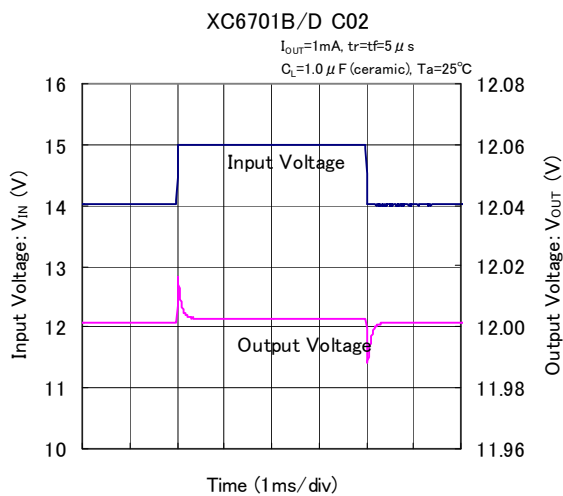


(6) Input Transient Response

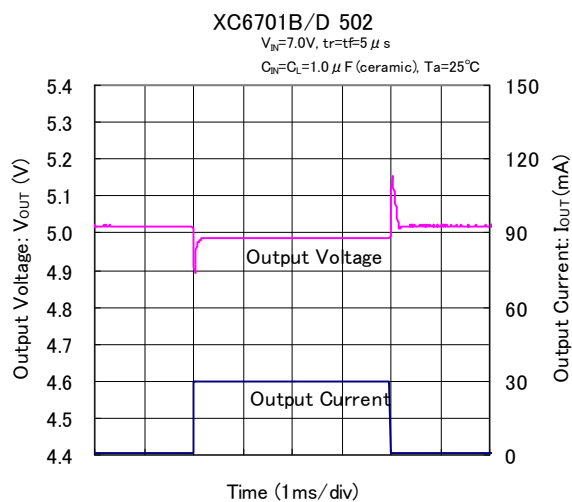
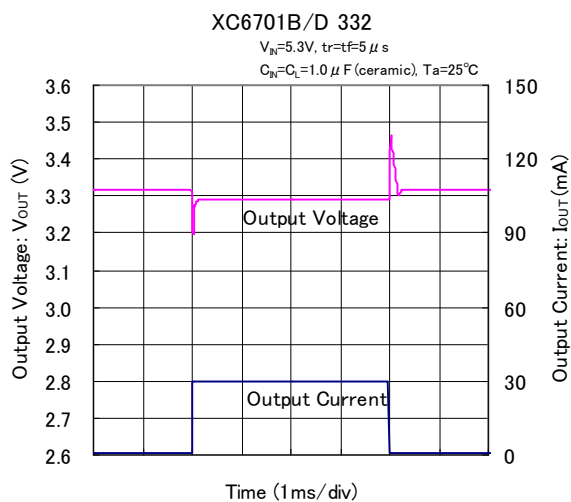


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Input Transient Response (Continued)

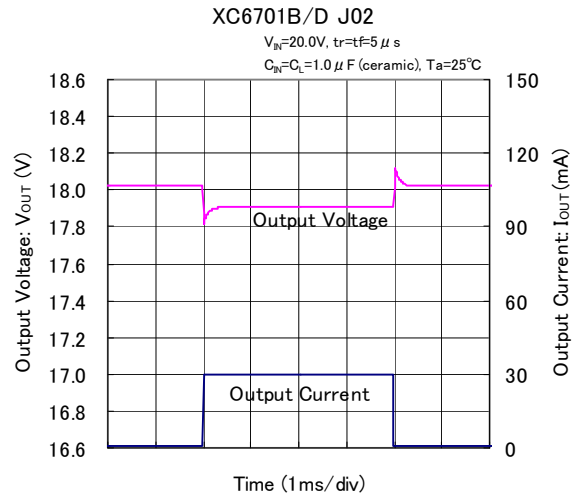
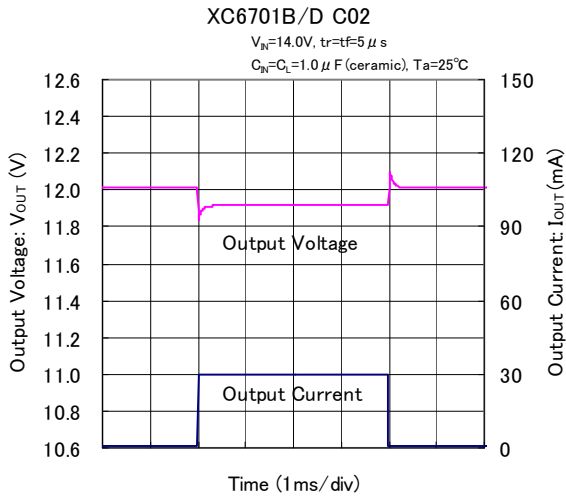


(7) Load Transient Response

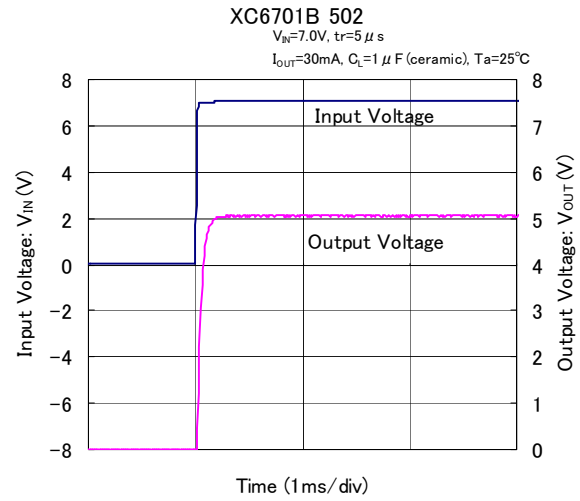
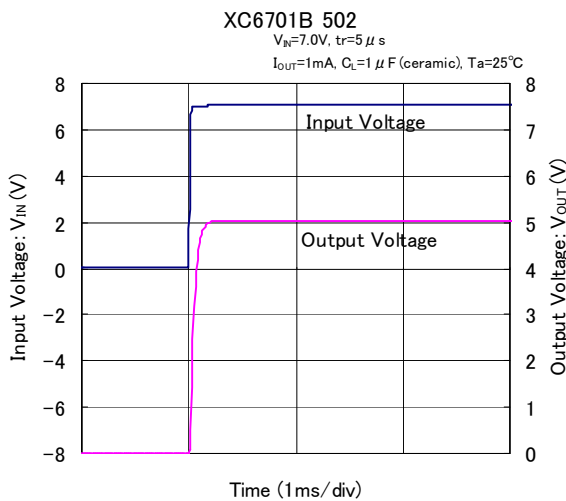
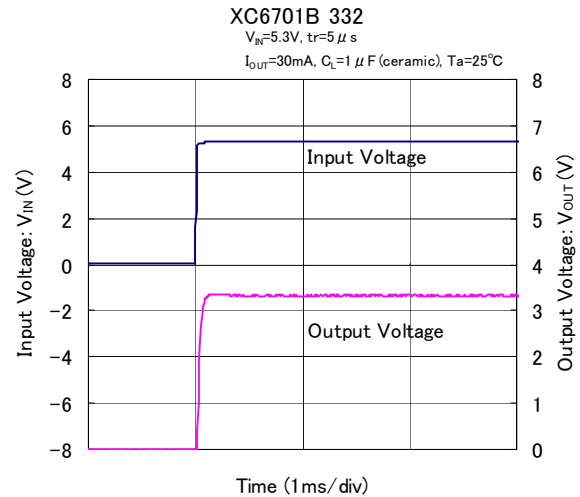
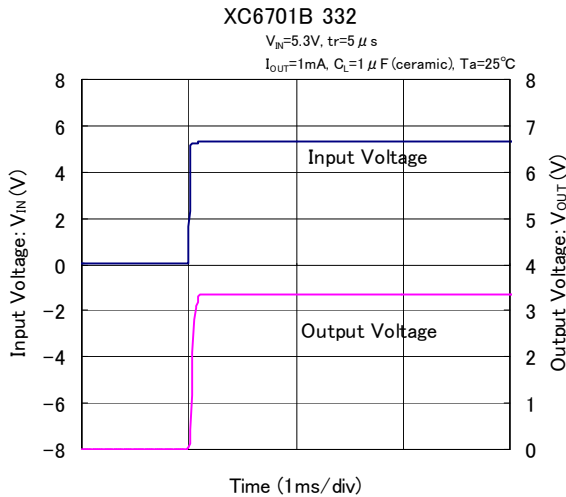


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Load Transient Response (Continued)

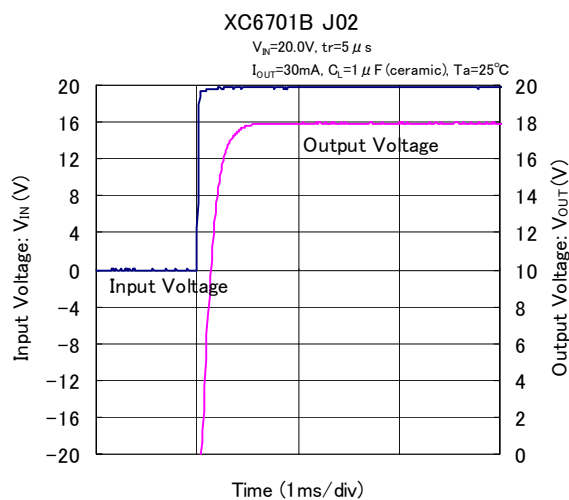
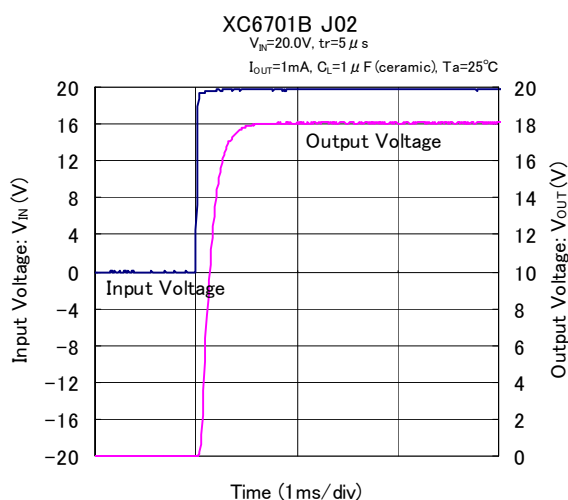
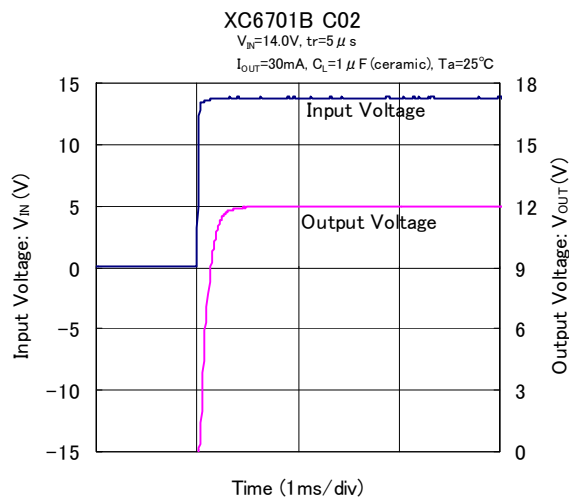
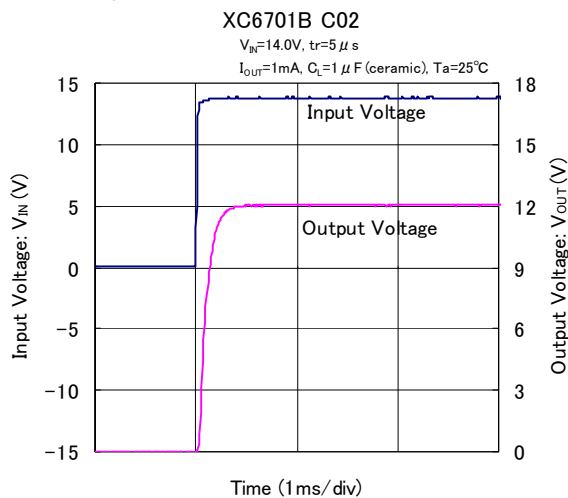


(8) Rising Response Time

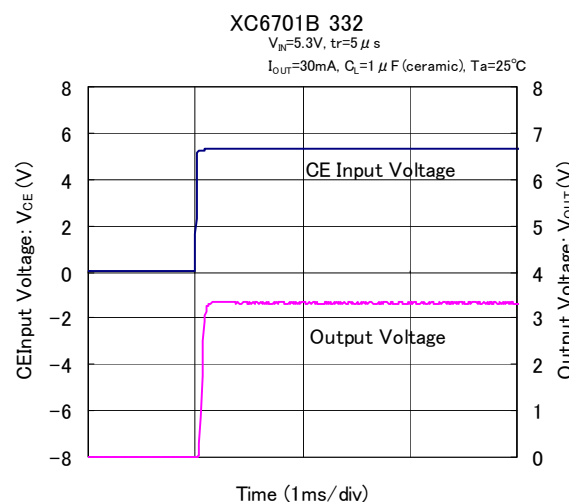
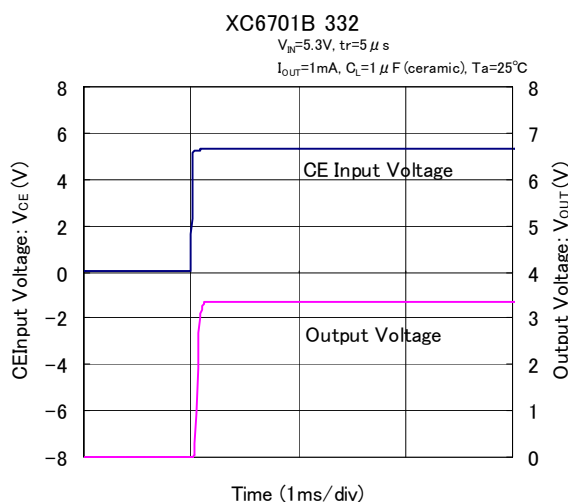


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Rising Response Time (Continued)

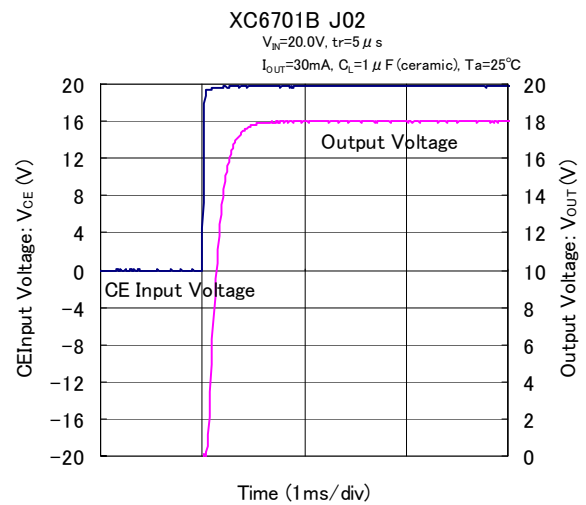
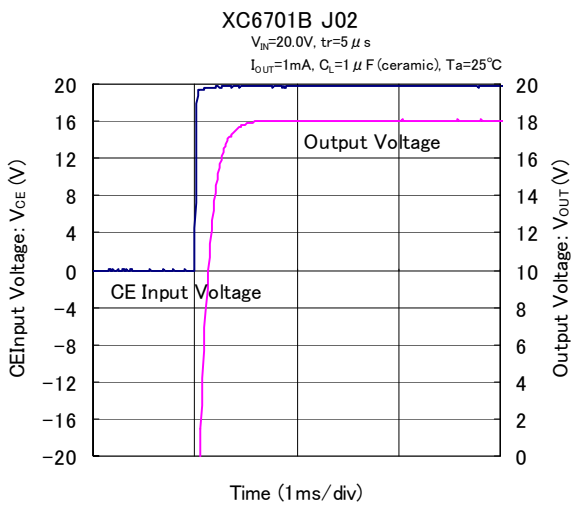
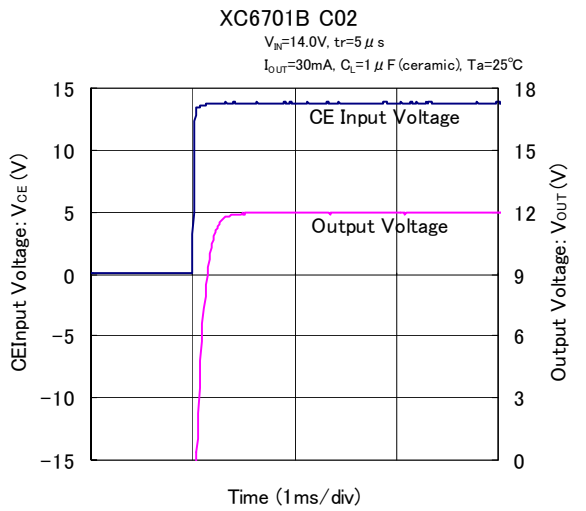
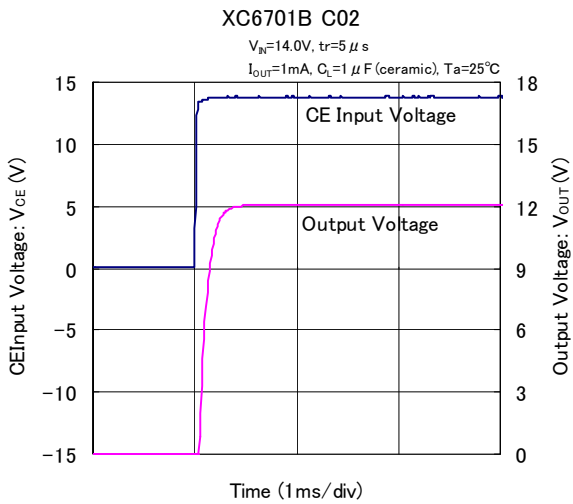
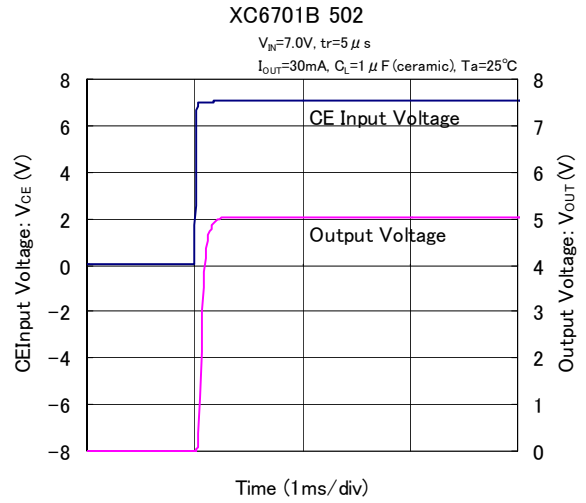
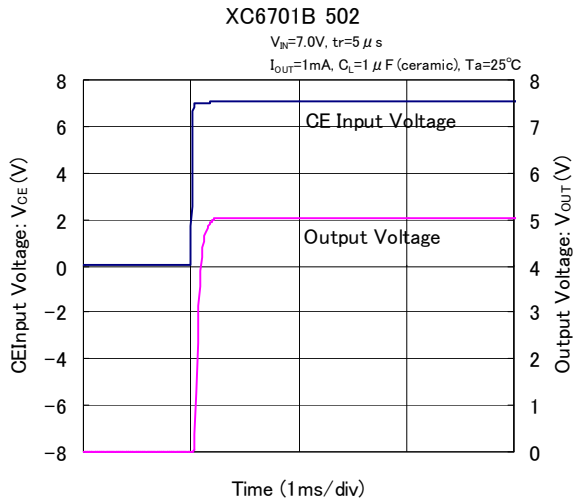


(9) CE Rising Response Time



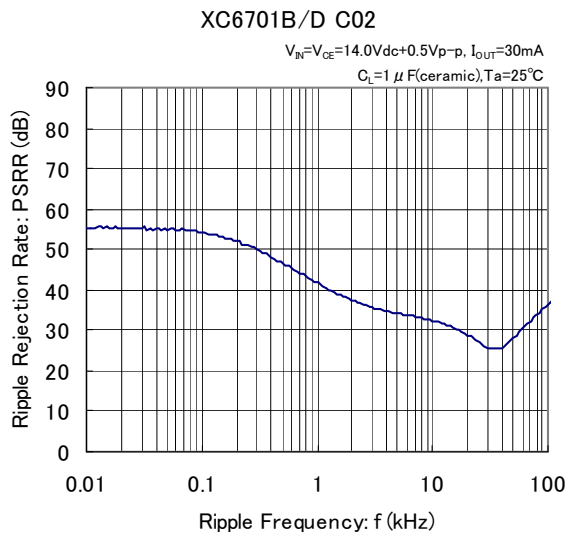
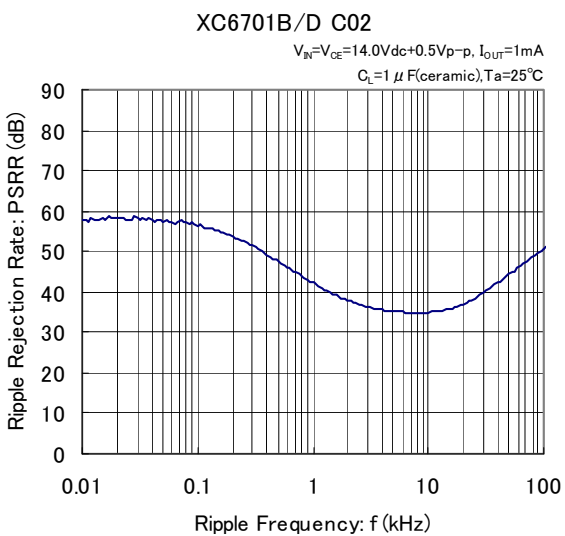
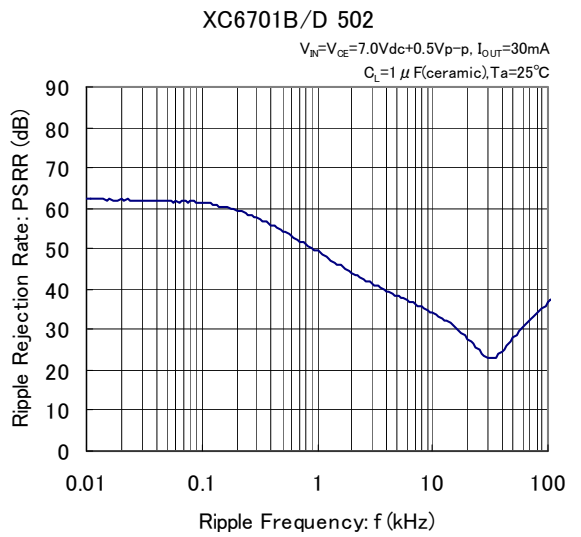
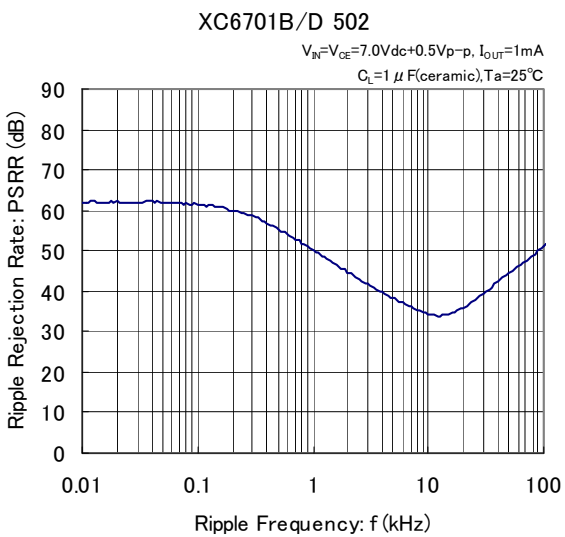
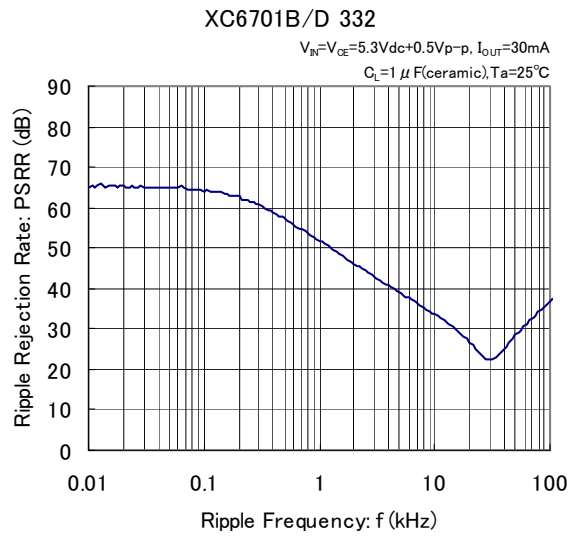
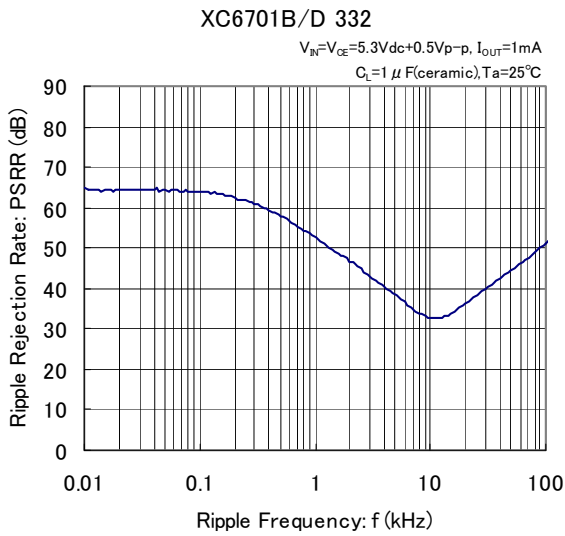
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) CE Rising Response Time (Continued)



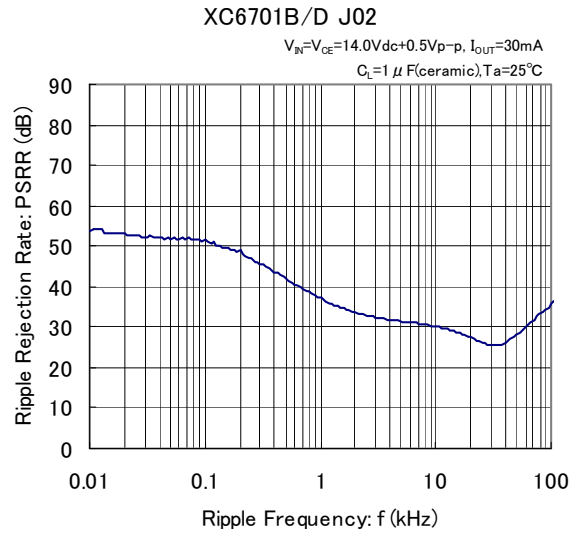
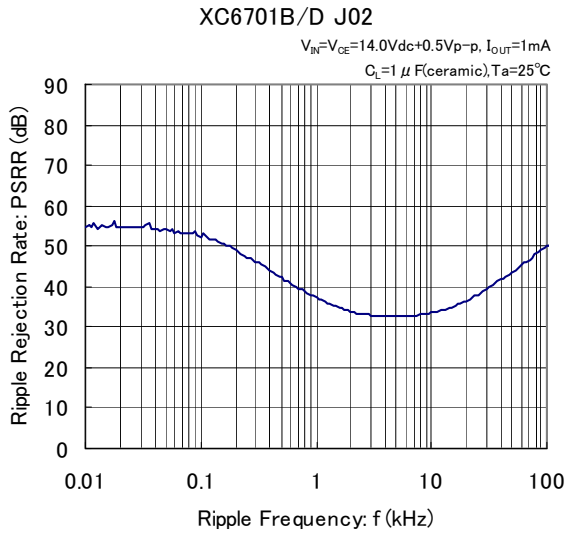
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) Ripple Rejection Rate



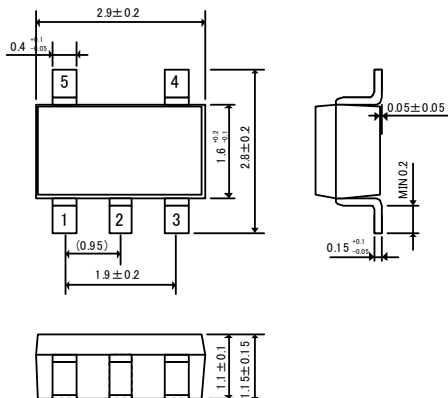
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) Ripple Rejection Rate (Continued)

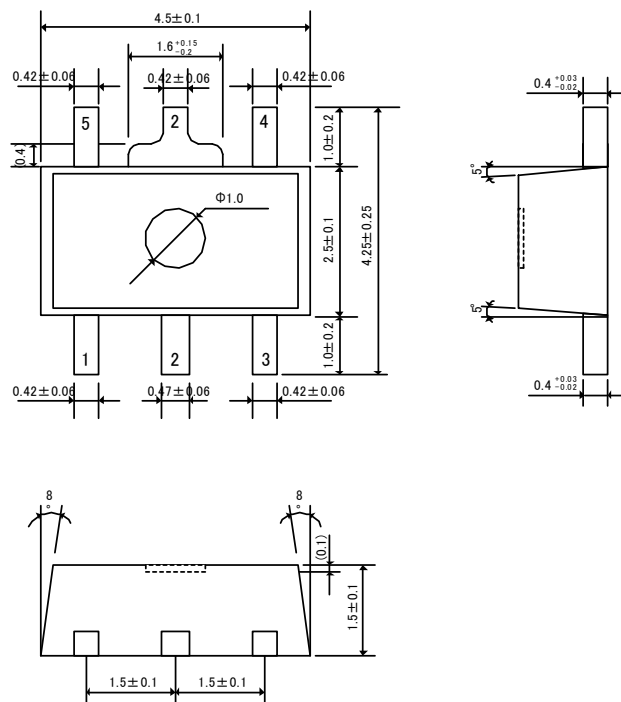


PACKAGING INFORMATION

SOT-25

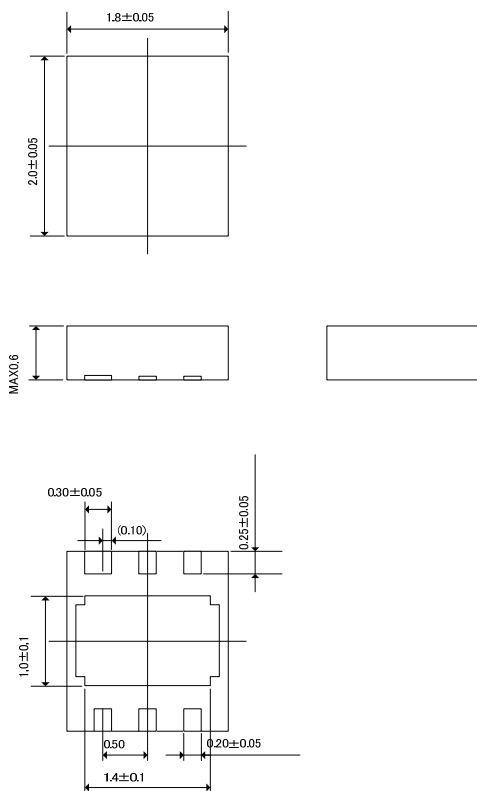


SOT-89-5

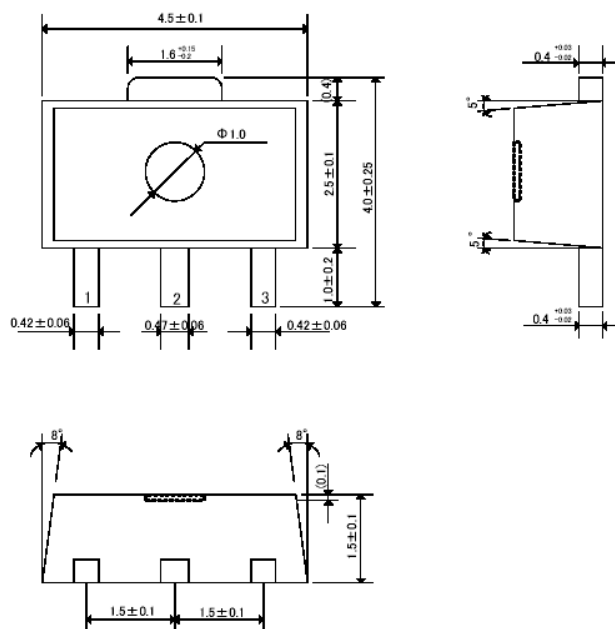


USP-6C

(unit : mm)



SOT-89

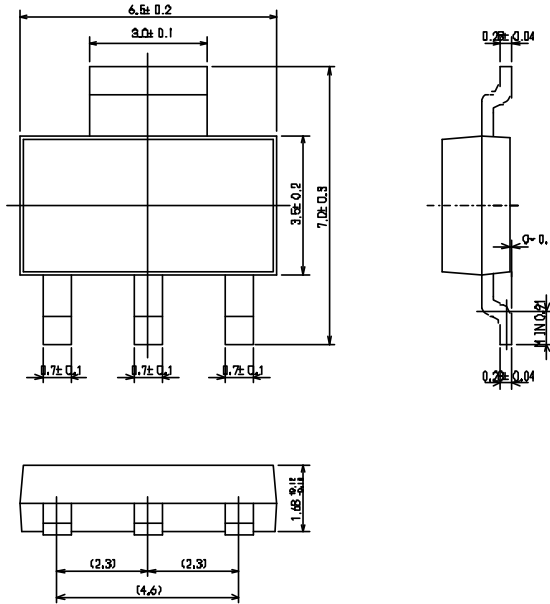


Note: The side of pins are not gilded, but nickel is used.

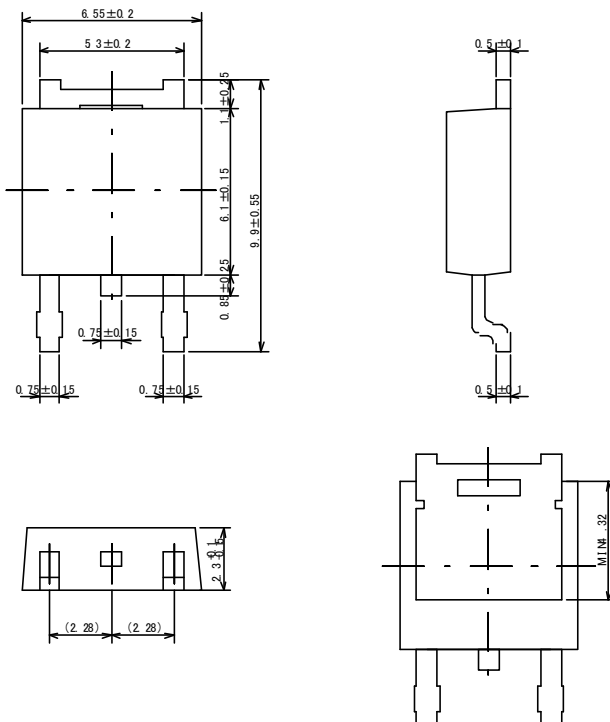
USP-6C Package

PACKAGING INFORMATION (Continued)

SOT-223

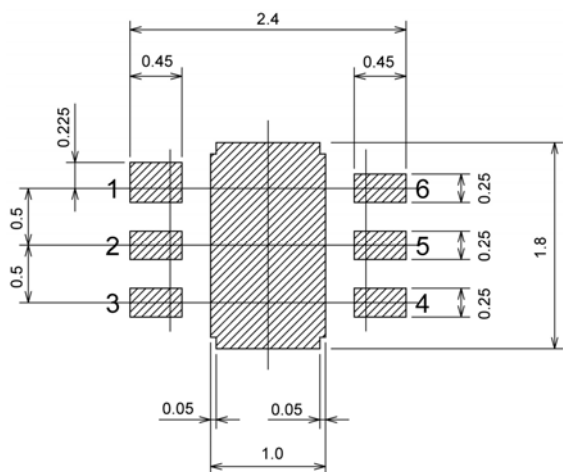


TO-252

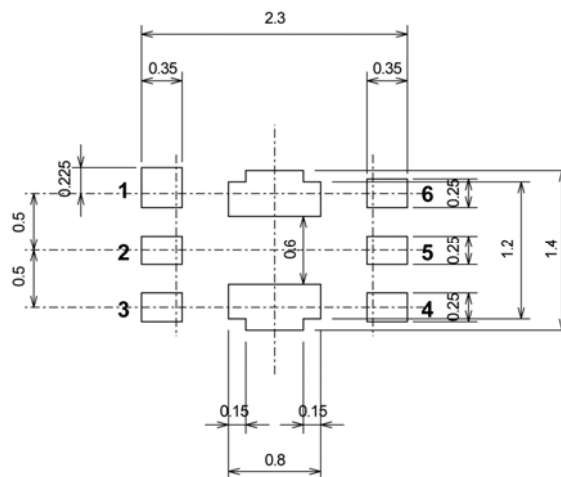


PACKAGING INFORMATION (Continued)

USP-6C Reference Pattern Layout



USP-6C Reference Metal Mask Design



PACKAGING INFORMATION (Continued)

SOT-25 Power Dissipation

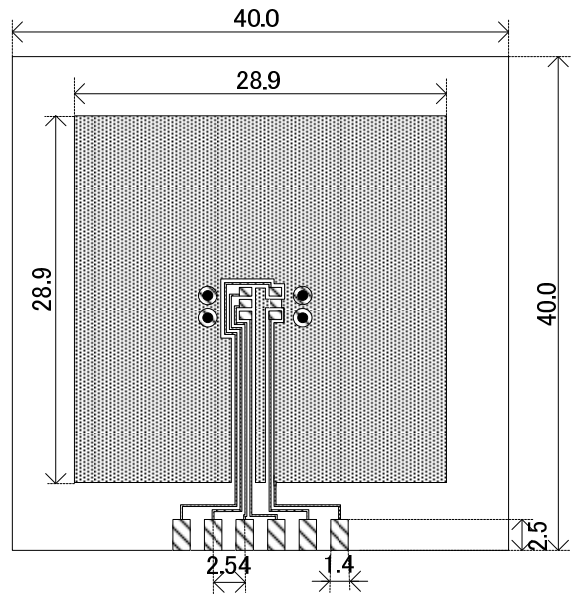
Power dissipation data for the SOT-25 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
- Ambient: Natural convection
- Soldering: Lead (Pb) free
- Board:
 - Dimensions 40 x 40 mm (1600 mm² in one side)
 - Copper (Cu) traces occupy 50% of the board area
 - In top and back faces
 - Package heat-sink is tied to the copper traces
 - (Board of SOT-26 is used.)
- Material: Glass Epoxy (FR-4)
- Thickness: 1.6 mm
- Through-hole: 4 x 0.8 Diameter

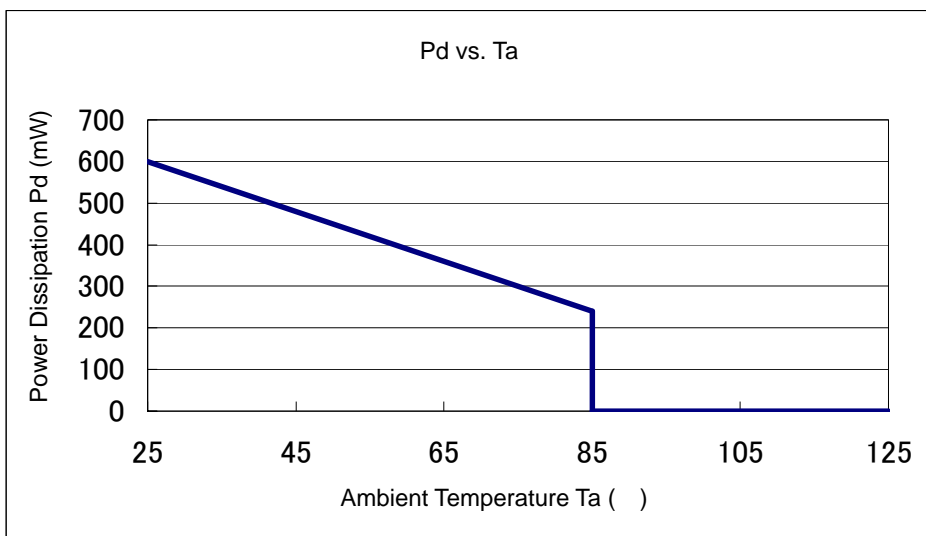


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Operating temperature

Board Mount ($T_j \text{ max} = 125$)

| Ambient Temperature (°C) | Power Dissipation Pd (mW) | Thermal Resistance (°C/W) |
|--------------------------|---------------------------|---------------------------|
| 25 | 600 | 166.67 |
| 85 | 240 | |



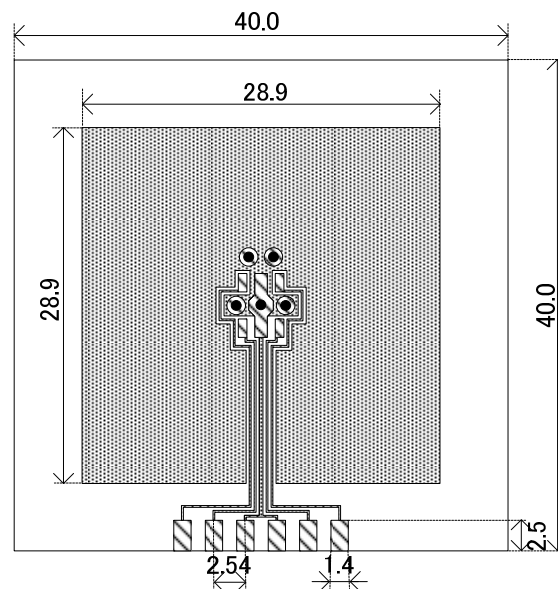
PACKAGING INFORMATION (Continued)

SOT-89-5 Power Dissipation

Power dissipation data for the SOT-89-5 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
- Ambient: Natural convection
- Soldering: Lead (Pb) free
- Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
- Material: Glass Epoxy (FR-4)
- Thickness: 1.6 mm
- Through-hole: 5 x 0.8 Diameter

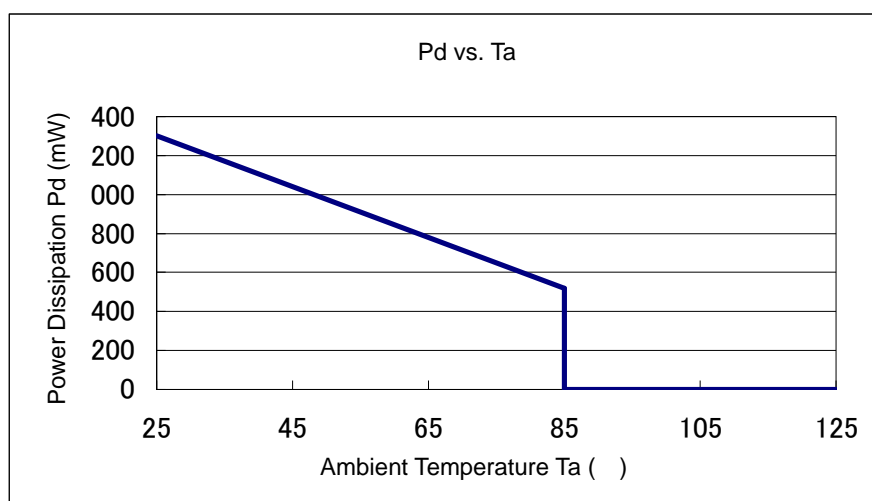


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Operating temperature

Board Mount ($T_j \text{ max} = 125$)

| Ambient Temperature (°C) | Power Dissipation Pd (mW) | Thermal Resistance (°C/W) |
|--------------------------|---------------------------|---------------------------|
| 25 | 1300 | 76.92 |
| 85 | 520 | |



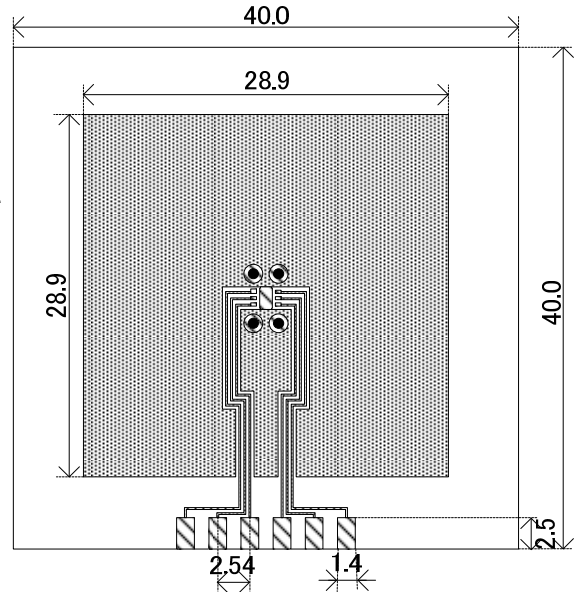
PACKAGING INFORMATION (Continued)

USP-6C Power Dissipation

Power dissipation data for the USP-6C is shown in this page.
 The value of power dissipation varies with the mount board conditions.
 Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
- Ambient: Natural convection
- Soldering: Lead (Pb) free
- Board: Dimensions 40 x 40 mm (1600 mm² in one side)
 Copper (Cu) traces occupy 50% of the board area
 In top and back faces
 Package heat-sink is tied to the copper traces
- Material: Glass Epoxy (FR-4)
- Thickness: 1.6 mm
- Through-hole: 4 x 0.8 Diameter

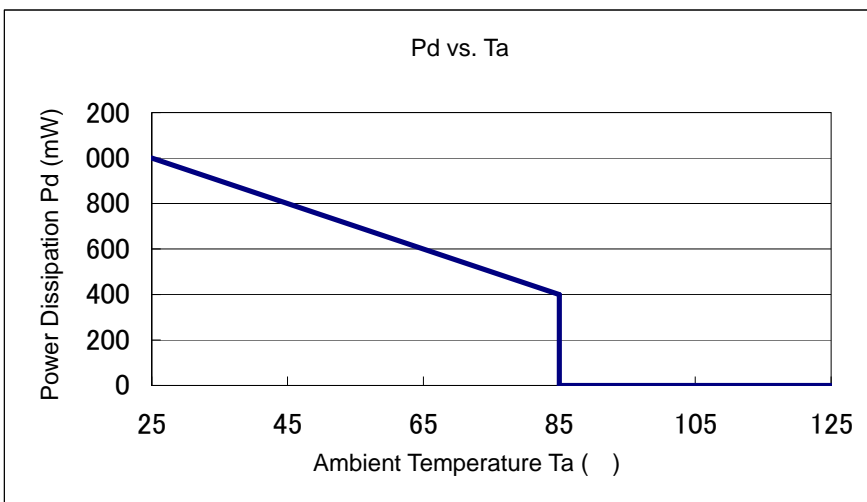


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Operating temperature

Board Mount ($T_j \text{ max} = 125$)

| Ambient Temperature (°C) | Power Dissipation Pd (mW) | Thermal Resistance (°C/W) |
|--------------------------|---------------------------|---------------------------|
| 25 | 1000 | 100.00 |
| 85 | 400 | |



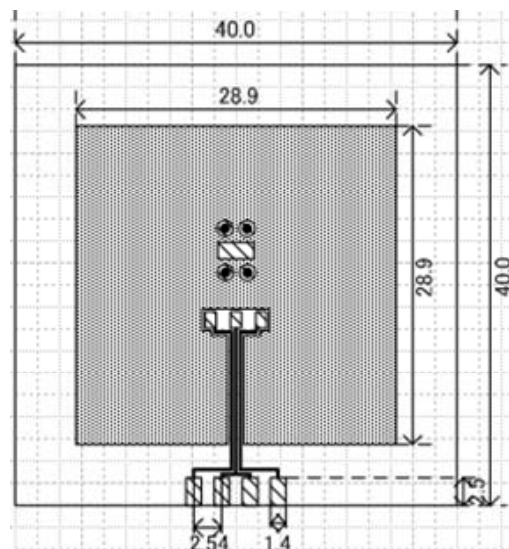
PACKAGING INFORMATION (Continued)

SOT-223 Power Dissipation

Power dissipation data for the SOT-223 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
- Ambient: Natural convection
- Soldering: Lead (Pb) free
- Board: Dimensions 40 x 40 mm (1600 mm² in one side)
Copper (Cu) traces occupy 50% of the board area
In top and back faces
Package heat-sink is tied to the copper traces
- Material: Glass Epoxy (FR-4)
- Thickness: 1.6 mm
- Through-hole: 4 x 0.8 Diameter

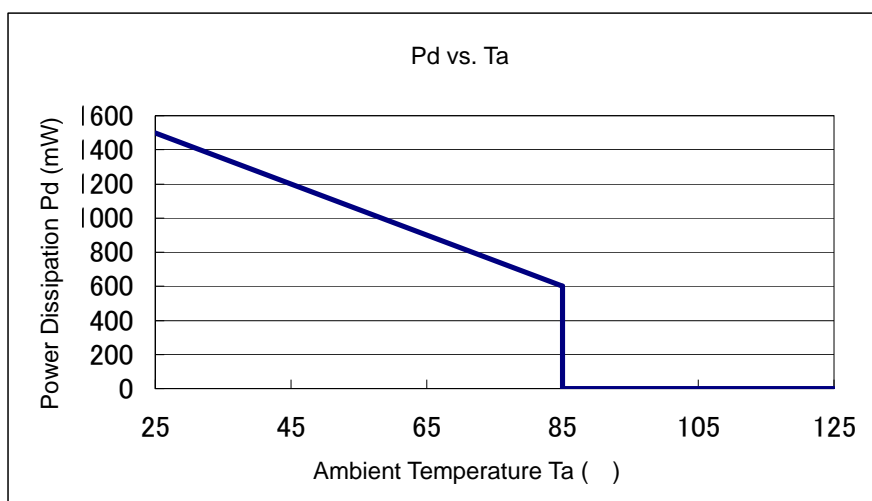


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Operating temperature

Board Mount (T_j max = 125 °C)

| Ambient Temperature (°C) | Power Dissipation Pd (mW) | Thermal Resistance (°C/W) |
|--------------------------|---------------------------|---------------------------|
| 25 | 1500 | 66.67 |
| 85 | 600 | |



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